

Terahertz Imaging and Security Applications

Erich Grossman

**National Institute of Standards & Technology
Quantum Electrical Metrology Division**

Terahertz Technology & Quantum Information Project
Boulder, CO, USA
co-workers:

Aaron J. Miller (NIST)

Arttu Luukanen (permanent address VTT)

Support from

NIJ (Chris Tillery),
TSA (checkpoint, Lee Spanier),
and DARPA (MIATA, Martin Stickley)



Outline

- **Application**
 - Concealed Weapons Detection scenarios
 - Penetration, spatial resolution, and other drivers for frequency range
- **Detection schemes, background**
 - Passive and active direct detection
 - Figures of merit, sensitivity limits
- **Antenna-coupled microbolometers**
 - Principle of operation, fabrication, characterization
 - Air-bridge microbolometers
- **Single-pixel active imaging: phenomenology**
- **2D Staring array : real-time video imaging**
 - System description
 - Imaging results
- **1D scanned array : active real-time imaging with large field-of-view:**
 - Active systems favor scanned architectures
 - System layout, component tests
 - Migration to 650 GHz
- **Sb quantum tunneling diodes**
 - Principle of operation, $I(V)$ and noise properties
 - Prospects for passive direct detection
- **Conclusions**

Theme :
What can be done,
without major breakthroughs,
for large-format, real-time,
low-cost THz imaging ?

THz Imaging Arrays

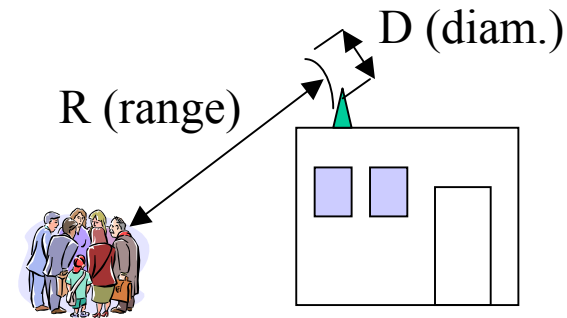
Application Scenario

- To image (detect and recognize) concealed threats
 - initially at short range (portal), e.g. 1.5 m
 - later at longer range, e.g. 10 – 50 m

Requires ...

- Diffraction-limited resolution and good transmittance

- $D = 1$ m (practical maximum) implies
- res > 2.5 cm at 8 m range knife, gun, or explosive ?
 - > 6 cm at 20 m
 - > 15 cm at 50 m which person ?
- this assumes $f = 100$ GHz (linear improvement with f)
- Transmittance rolls off smoothly with increasing frequency (NIST measurements next page)



$$\text{Res} = (R/D)\lambda$$

Optimal Frequency for Penetration

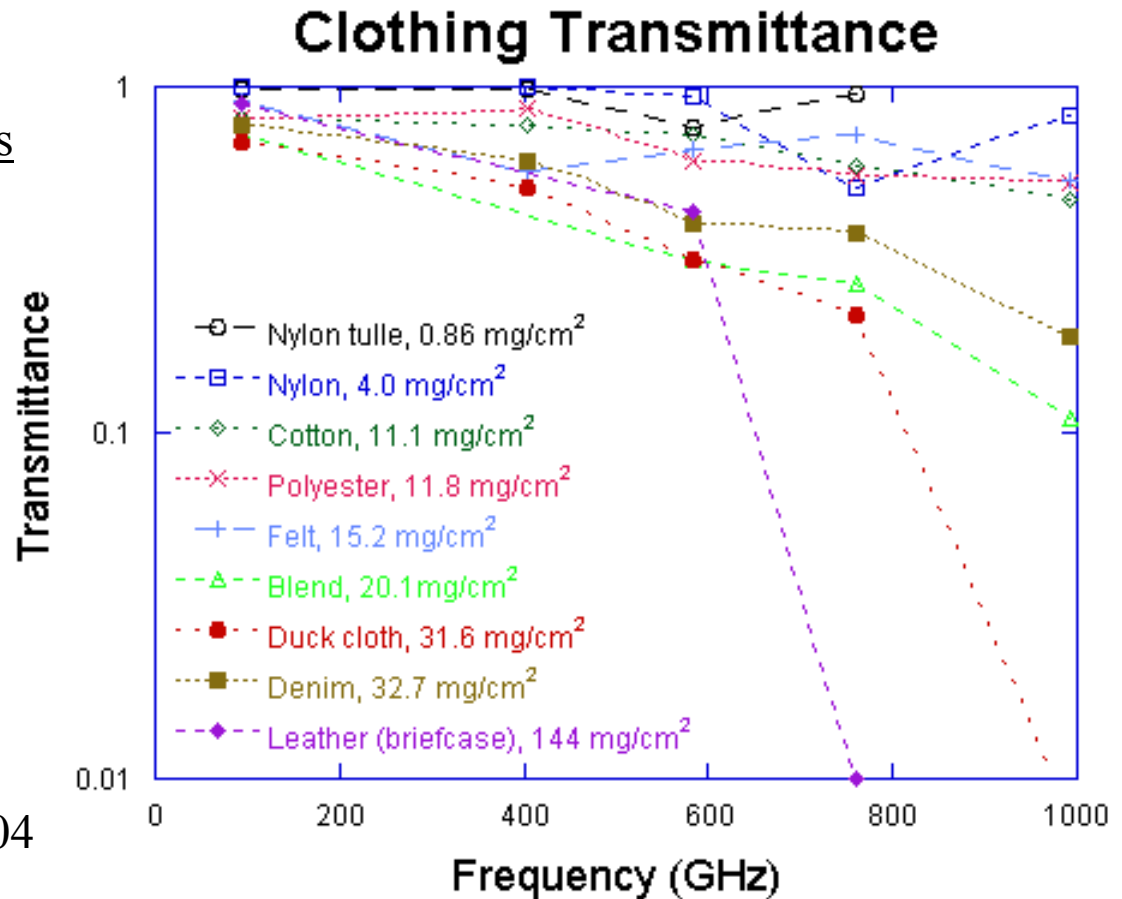
Other 95 GHz measurements

Goldsmith (93):
0.04 – 1 dB

Huegenin (96):
< 1 dB dry
3.5 dB wet

Sinclair (01) (40-150 GHz):
1 – 6 dB

See also Bjarnason et al. 2004
(THz and mid-IR)



From Grossman et al. Proc. SPIE, 2002

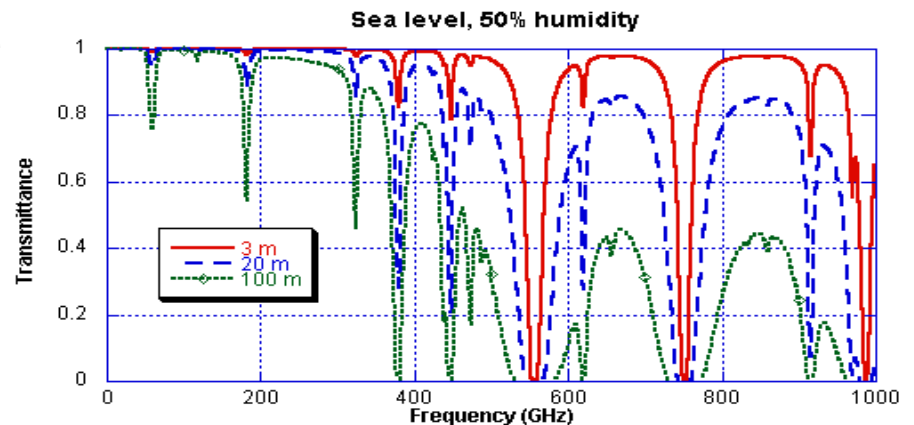
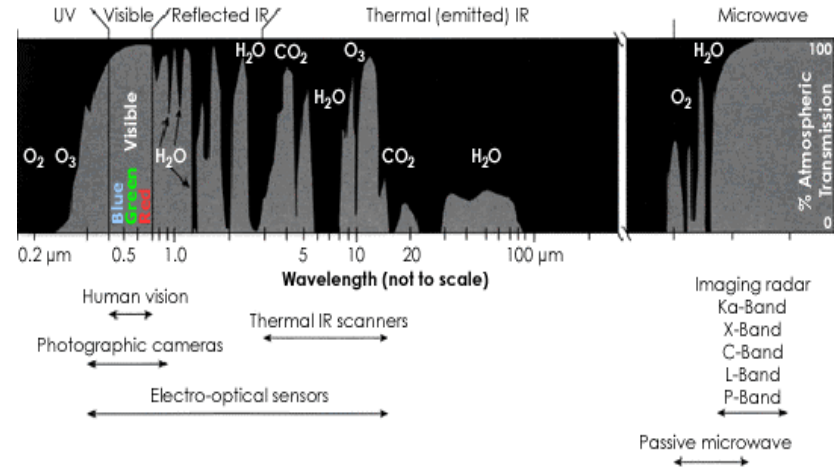
Application Requirements (cont.)

- Users care about
 - Image quality – i.e. resolution and sensitivity -> ROE curve
 - Throughput (speed)
 - Privacy (user-interface) and Safety
 - Footprint (in some cases)

 - Range
 - Cost
- Technical drivers
 - Penetration and diffraction-limited resolution
 - Atmospheric transmission
 - Technological maturity

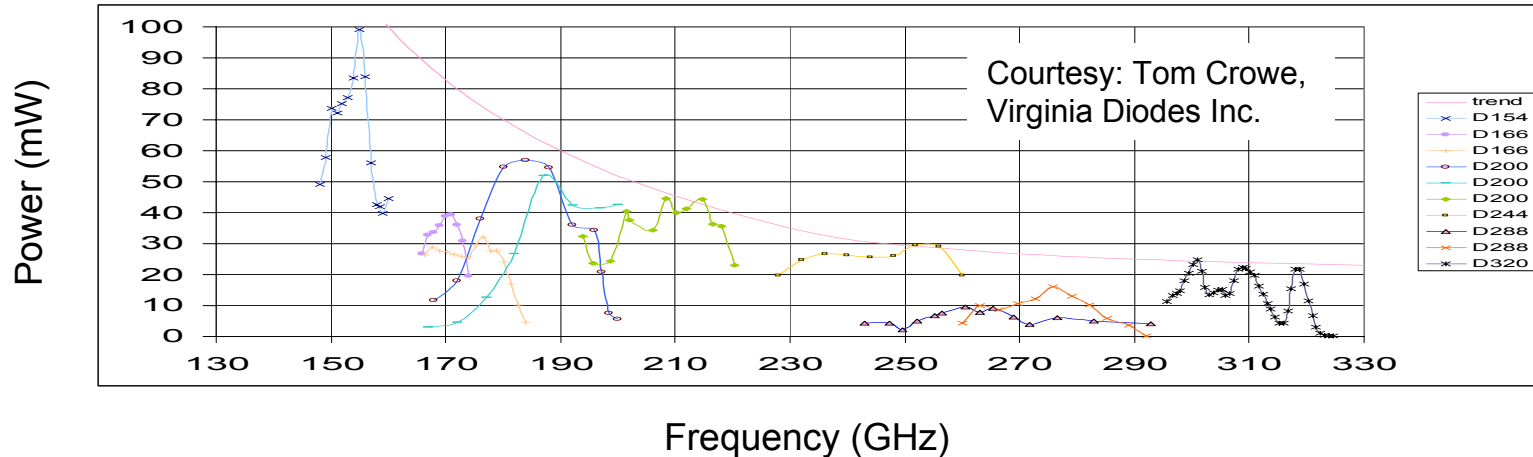
Atmospheric Transmission

- Swamped with rotational/vibrational spectra of molecules
- Terrestrial atmospheric transmission limited by H₂O absorption to a few windows (3 mm, 2 mm, 1.3 mm, 0.85 mm, 0.45 mm, 0.35 mm) for long ranges
- 1/e absorption length is comparable to range for many interesting applications, i.e. 10's of m



Technological Maturity, esp. Sources

- Fundamental W-band (Impatt and Gunn diode) sources show $P \sim 1/\text{duty cycle}$
 - expected for thermally limited devices
- ~300 mW CW ~15 W pulsed (d=.5%) (Quinstar)



- High efficiency varactors may show opposite behavior; key for migration of active systems to THz range

Duty cycle	Output power at 70 GHz (W)	Efficiency (%)	$P_{\text{out}} * D^{1/2}$ (W)
CW	1.4 W	17.5	1.4
10 %	2.0 W	25	0.63
4 %	2.7 W	33.8	0.54
2 %	3.1 W	38.8	0.44



Initial VDI 600 GHz varactor chain
Peak power 1.2 mW at 640 GHz

PMMW is old-hat, isn't it ?

- Single pixel scanned image
- 30 minutes acquisition time
- Since 2001, realtime readout

available on some systems

- Sensitivity (500 – 5000 K)

“fixed” This is 0.1 – 1 % of quantum limit, a practical limit for uncooled receivers



Millimeter wave detection of concealed weapon.

millitech
Contraband Detection Systems

Features

- Real time imaging using standard video
- Covert, passive operation
- Penetrates through clothing/obscureants
- Complete turnkey systems available
- Transportable and fixed installations

Applications

- Concealed weapons (metallic, ceramic nonmetallic)
- Plastic explosives and drug screening
- Air/Sea/ports/airport security
- Embassy/government official protection
- High value air/feroce control
- Late enforcement night vision/SWAT operations
- Covert screening of visitors/employees

Description

Millitech's proprietary Millivision™ millimeter wave passive imaging technology utilizes the unique capability of millimeter wave to image objects through clothing and other obscuring materials in real time without transmitting a signal to the target. The image is derived from the same principle as is used in Fourier transform imaging arrays (FTIR). The camera incorporates a focal plane array (FPA) consisting of several large numbers of high sensitivity receivers with integral antenna elements located at the focal plane of a lens antenna. The output signal of the array is processed by proprietary software and signal processing systems providing a visual readout to the camera. The difference in black body radiation between the target and the background is processed to create a false color image presentation.

PERFORMANCE TABLE

PARAMETER	TYPICAL	OPERATIONAL
Resolution	1000 x 1000	1000 x 1000
Frame Rate	30 FPS	30 FPS
Scan Rate	1000 FPS	1000 FPS
Field of View	1000 x 1000	1000 x 1000
Operating Temperature	-40 to +60	-40 to +60
Power Consumption	1000 W	1000 W

Fixed Antenna Camera Specifications

Focal plane array circuit card

9

• 1995: Millitech catalog

Active vs Passive Imaging - Sensitivity

- Passive mmw signals are small; This is much harder than in IR
 - For $f=100$ GHz, bandwidth= 100 GHz, 1 diffraction-limited pixel :
Total power = 400 pW :
Outdoor contrasts are ~ 200 pW
BUT Indoor contrasts are < 10 pW

This is fundamental, $P=kTB$

- To detect < 1 pW in $1/30$ s with $S/N=10$, you need either cryogenic detection ($NEP=3 \times 10^{-14}$) or coherent detection ($T_{noise}=12,000$ K)
 - coherent detection is complex and expensive

$$1\sigma = \frac{NEP}{\eta\sqrt{2\tau}}$$

- | | |
|--|-----------|
| • 100 GHz worth of indoor blackbody emission | 1.4 pW/ K |
| \$ 5000 active source | 10 mW |

-Active imaging should be easy, even with incoherent detection

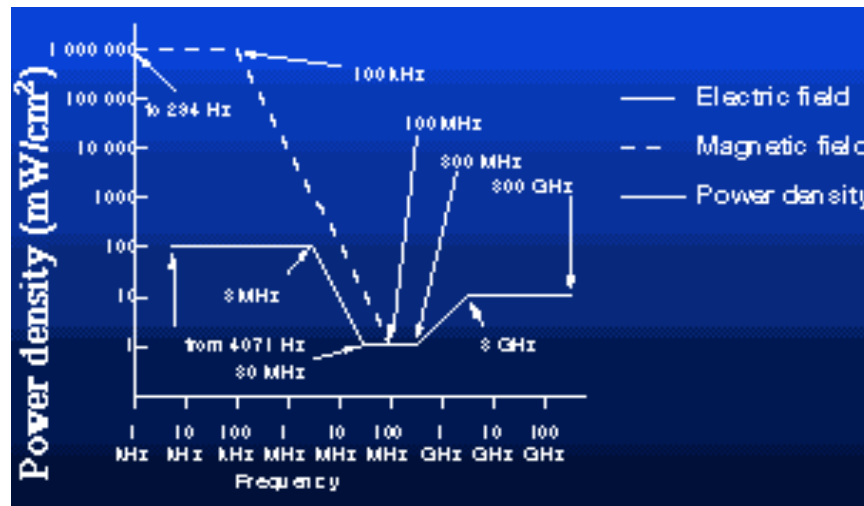
What about Safety ?

- FCC Ruling based on ANSI/IEEE standard C95.1-1992, for 100 GHz

1.0 mW/cm² (general public)

5.0 mW/cm² (controlled access)

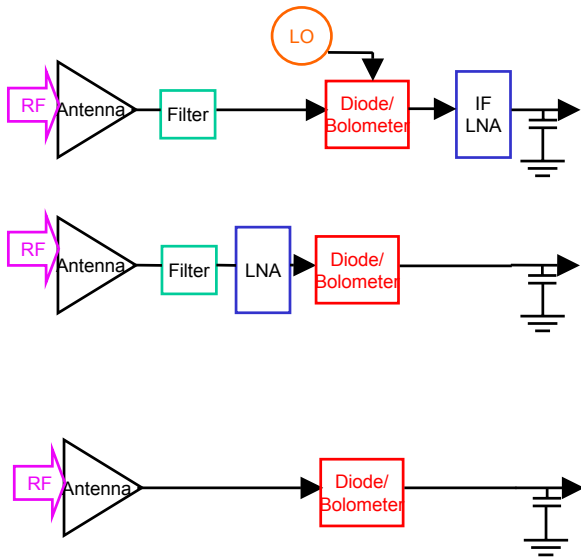
Occupational (controlled access) field strength limits



Not an issue for mmw or THz active imaging;
100 mW across 1 m² body area is x100 below guideline

THz Detection: technology matrix

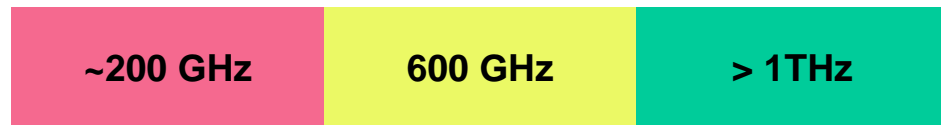
- (Passive) kilopixel imaging at video rates at mm/sub-mm waves



Technology	Sensitivity	Price
Coherent heterodyne	Good	Huge
Coherent direct (with preamplification)	Good	Large
Incoherent direct (no preamplification)	Moderate	Small
Antenna coupled microbolometers	Poor (active only)	Tiny

Decreasing complexity
 Decreasing sensitivity
 Increasing detector requirements

Maximum frequency



Figures of merit (Passive detection)

- For direct (incoherent) detectors, typically *Noise Equivalent Power* (NEP) [W/Hz^{1/2}]

$$\Rightarrow \text{SNR} = \frac{\eta P_{sig}}{NEP_e} \sqrt{2\tau_{int}}$$

- For coherent heterodyne typically expressed as *noise temperature*

$$\Rightarrow T_N = \frac{NEP}{k_B \sqrt{\Delta\nu}}, [\text{K}]$$

- For passive detection of thermal (continuum) targets, *Noise Equivalent Temperature Difference* (NETD) is most useful (includes detection bandwidth)

$$\Rightarrow \text{NETD} = \frac{NEP}{\partial P / \partial T_{target} \sqrt{2\tau_{int}}} \approx \frac{NEP}{nk_B \Delta\nu \sqrt{2\tau_{int}}}, [\text{K}]$$

In Rayleigh- Jeans limit

- With active illumination, the most useful FOM is *Noise Equivalent Reflectance Difference* (NERD)

$$\Rightarrow \text{NERD} = \frac{\sigma_p}{P_{pp}} = \left(\frac{NEP}{P} \right) \left(\frac{8L^2}{D^2} \right) \frac{N_{pix}}{\epsilon_s R(2\tau)^{1/2}}$$

Distance

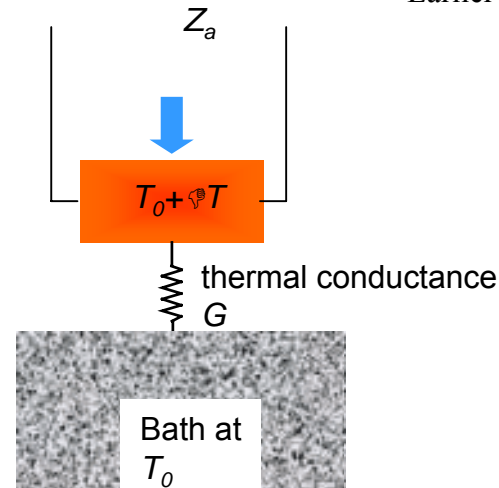
Aperture diaam.

average reflectance

Antenna-coupled Microbolometers

Antenna-coupled microbolometers

- A thermally isolated, resistive termination for a lithographed antenna
- Signal coupled to the bolometer changes its temperature: $\Delta T = P_{inc} / G$
- A DC current is used to sense the resistance of the bolometer, given by $R = R_0(1 + \alpha \Delta T) \approx R_0(1 + \beta I^2)$
- Electrical responsivity $S_e = \beta I$
- Noise contributions:
 - Phonon noise
 - Johnson noise
 - 1/f noise
 - Amplifier noise
- For room temperature devices, NEP is limited by Johnson noise



Earlier work on ACMBs

Tong 1983

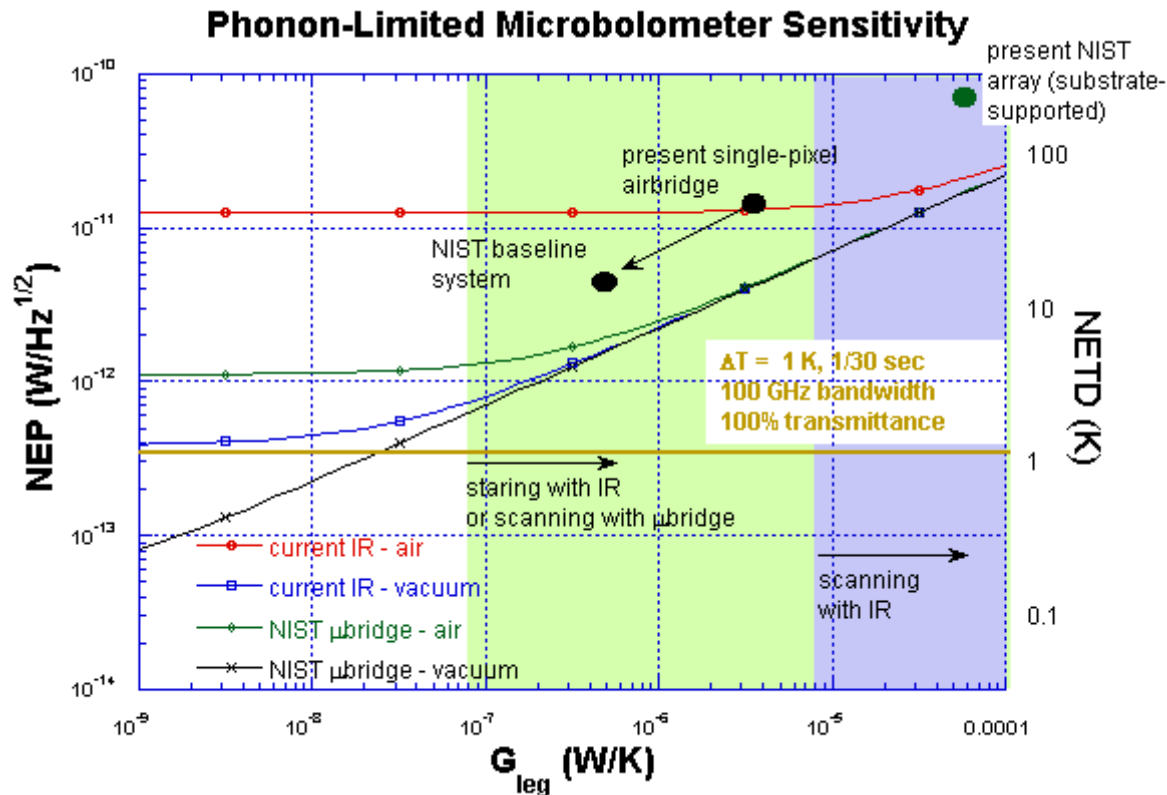
Rebeiz 1990

Hu 1996

$$NEP_e = \frac{\sqrt{4k_B T^2 G}}{\alpha \sqrt{\Delta T_{bias}}}$$

Microbolometer Sensitivity Limits

- For passive imaging, ACMB's lack the necessary sensitivity



How the calculation works:

$$P_{\min} = \text{NEP}/\sqrt{2\tau}$$

$$\text{NEP} = \sqrt{4kT^2G}$$

$$G = G_{\text{dev}} + G_{\text{air}} + G_{\text{rad}}$$

$$G_{\text{air}} = (.025 \text{ W/m-K})A/L$$

$$G_{\text{rad}} = dP/dT \text{ where}$$

$$P = \sigma T^4 A \text{ or } \pi^2 k^2 T^2 / 6h$$

(multimode or single-mode)

For current IR,

$$A = 50 \times 50 \text{ } \mu\text{m}^2,$$

$$L = 2.5 \text{ } \mu\text{m} \text{ (current) or } 50 \text{ } \mu\text{m} \text{ (high aspect)}$$

For NIST microbridge,

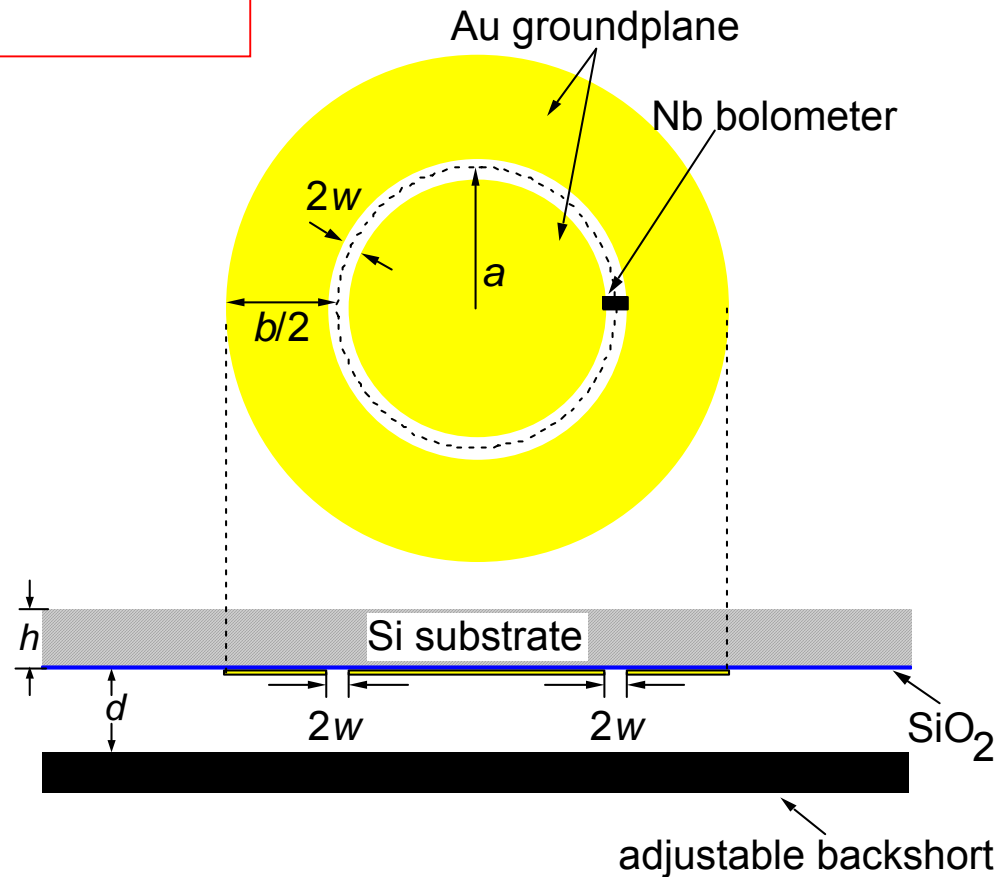
$$A = 2 \times 10 \text{ } \mu\text{m}^2,$$

$$L = 2 \text{ } \mu\text{m}$$

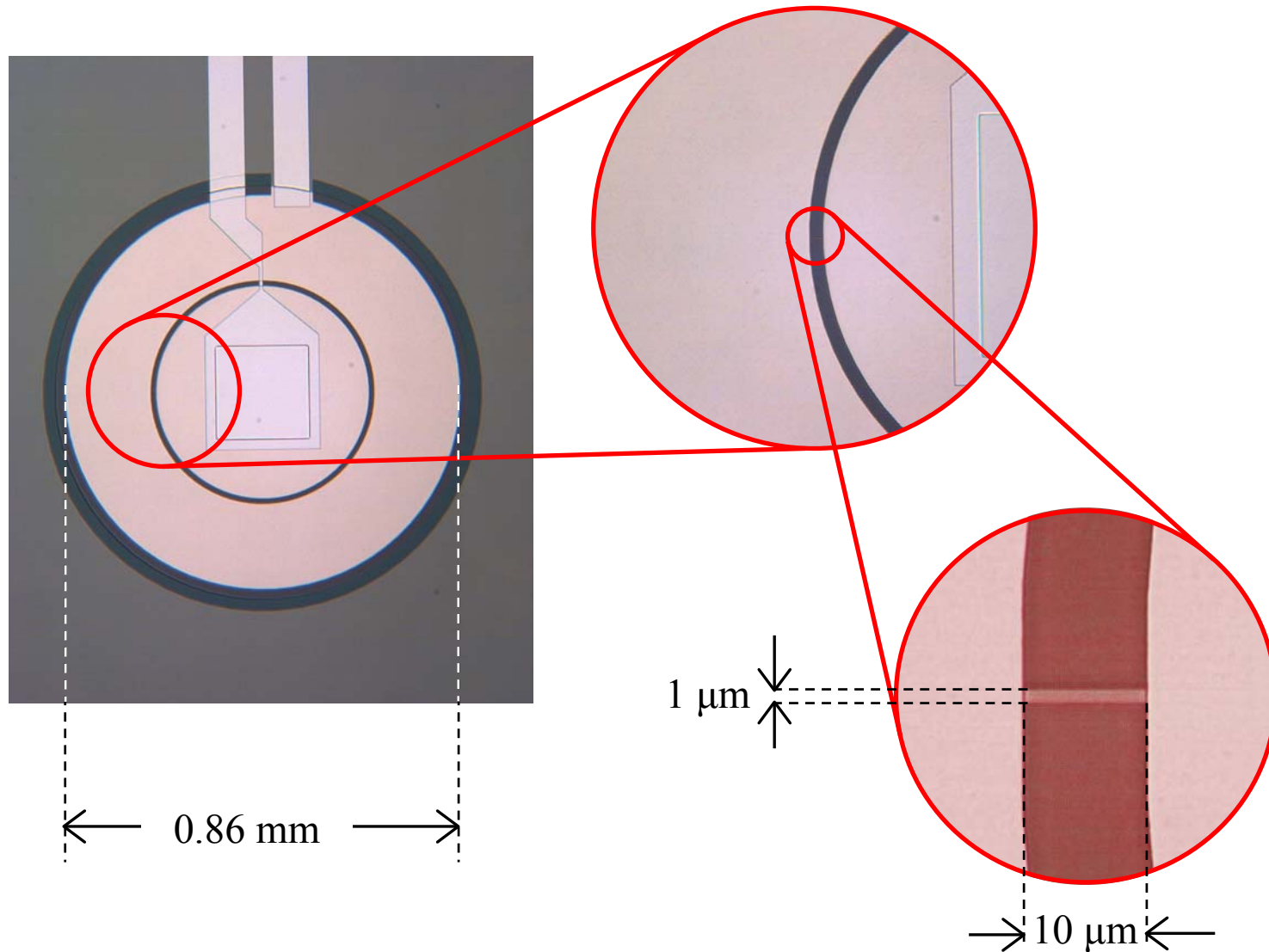
Slot-ring Antenna Configuration

The problem : High efficiency mmw feed antennas are generally not array-compatible

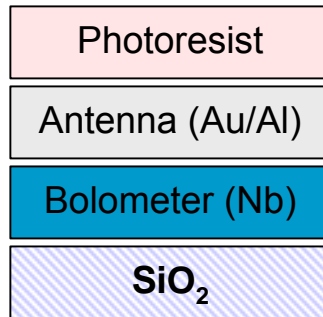
- Large-format array precludes substrate lenses or horns
- Slot transmission line; circumference = λ_{guide}
- Electrically thin substrate
 $h < \lambda_{\text{dielectric}} / 20$ (= 50 μm)
- $3\lambda_0/4$ backshort to raise directivity and recover backside coupling
 - -3 dB beamwidth = 21°
 - antenna impedance 103-48j Ω



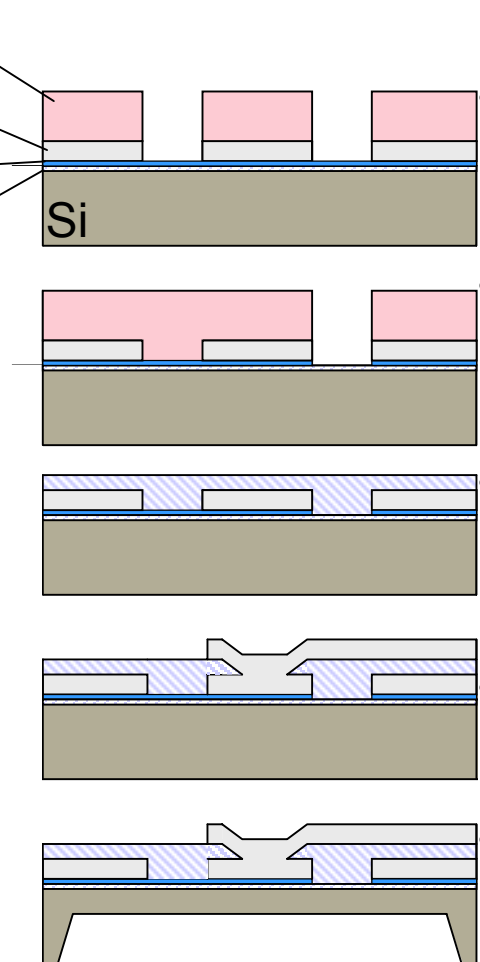
Substrate-Supported ACMB



FPA fabrication



- Simple fabrication: only Nb, Au (or Al), SiO₂
- Currently using contact lithography
- two non-trivial processing steps: crossovers over Au; backside thinning to 50 μm under each pixel
- Processing yield typically >90 %



Deposit bolometer-antenna bilayer, spin & pattern photoresist mask, define slot

Pattern photoresist mask, remove Au from on top of the bolometer

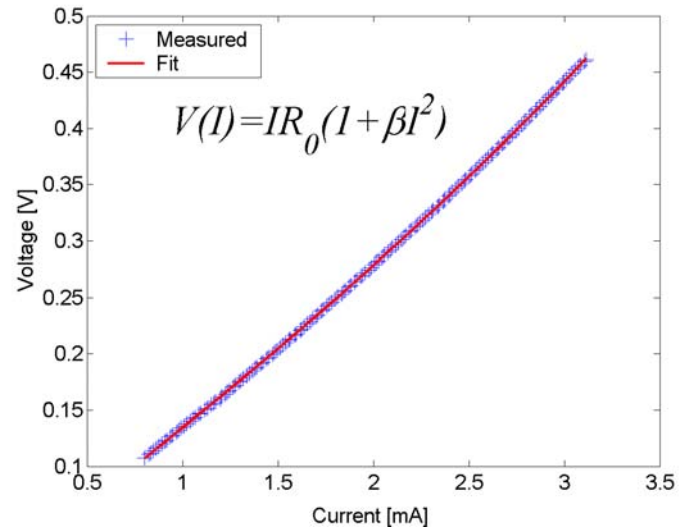
Deposit SiO₂ for crossovers

Define vias through the SiO₂, deposit top wiring

Perform backside etch of Si under each pixel

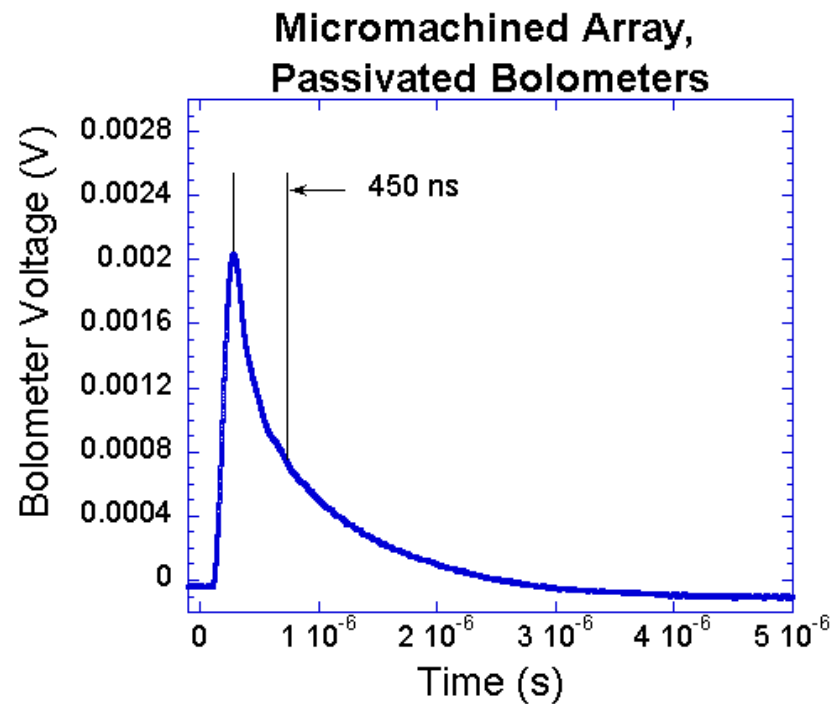
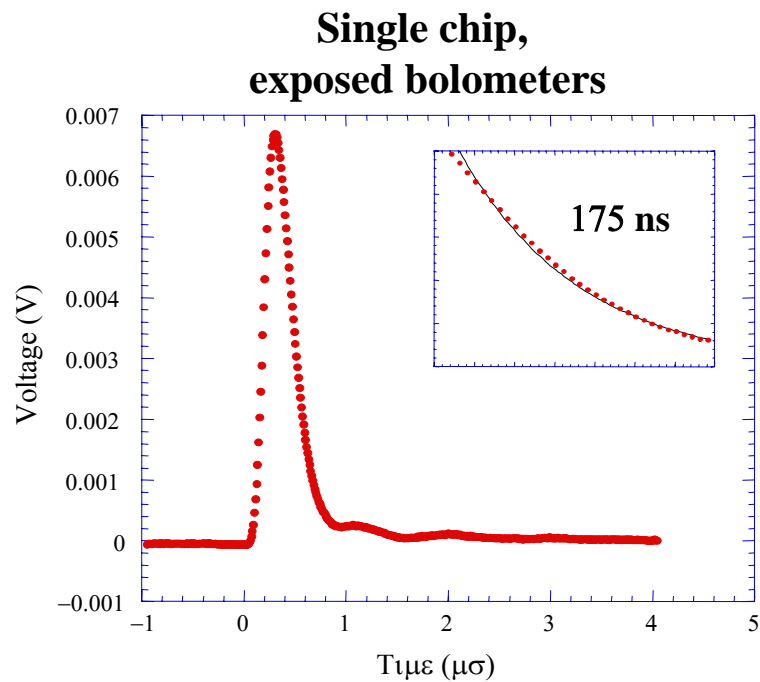
FPA Characterization

- Physics of self-heated bolometers extremely well understood
- Readout electronics allow for the simultaneous measurement of all 120 $V(I)$ curves; Fit to the $V(I)$ gives R_0 , specific responsivity β [V/W/mA]
- Compared to Vox, Nb is lower responsivity but also lower noise
- Electrical:
 - $V(I)$ curves of all pixels
 - Noise
 - Uniformity
- Optical
 - Efficiency
 - Polarization response
 - Speed

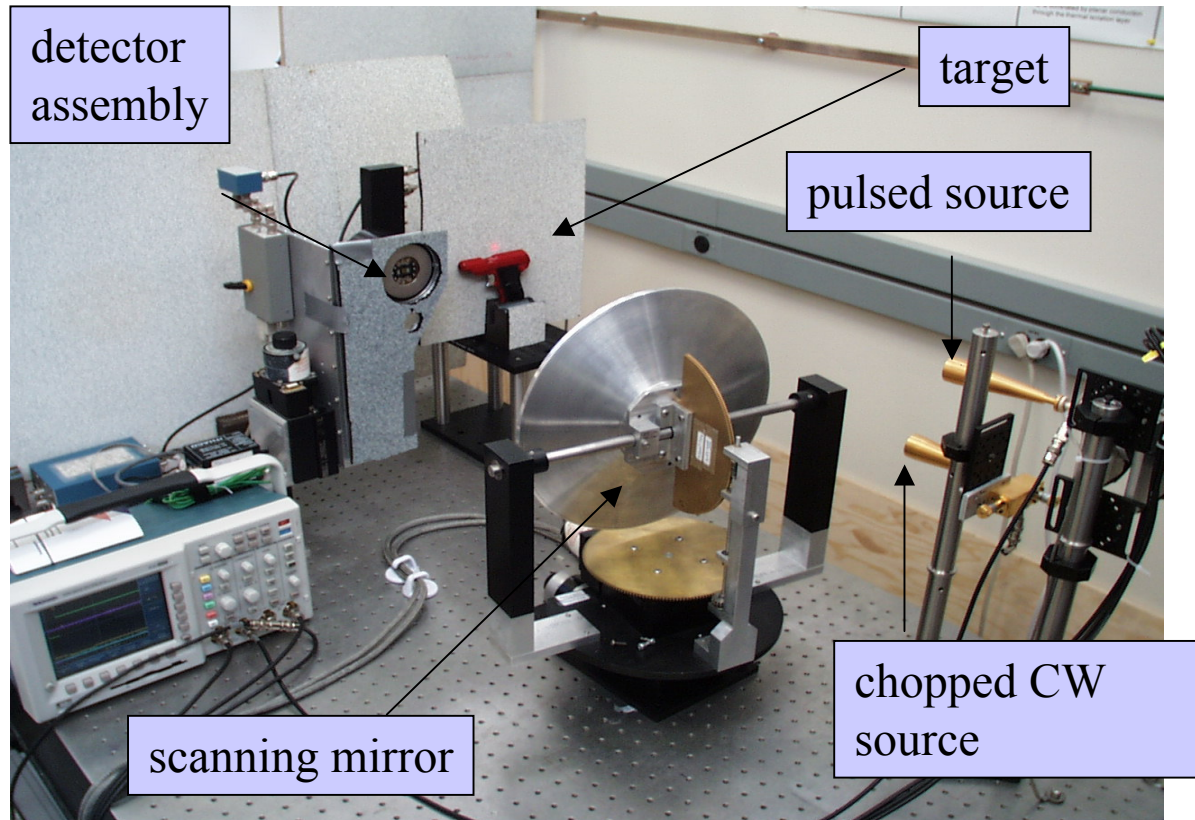


Passivated bolometer properties

- Oxidation is much slower, bolometers can be biased hotter
- Approximately x 8 higher optical responsivity
- Response is somewhat slower

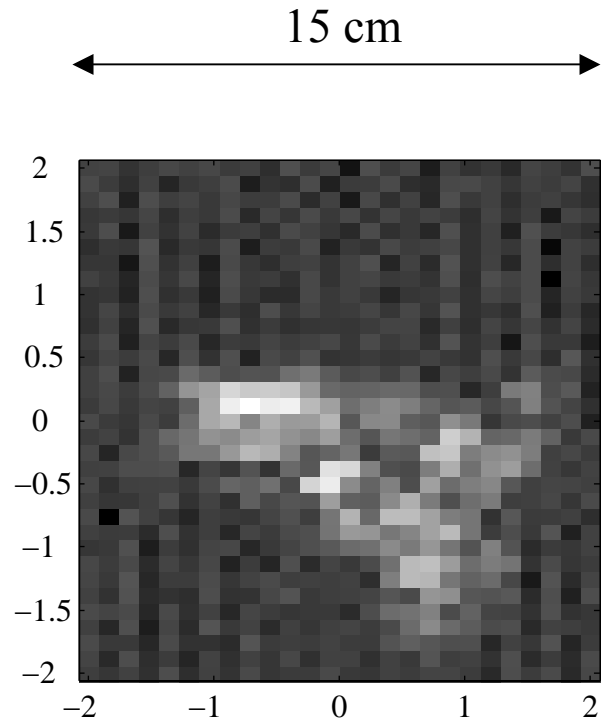


Scanned Imaging System



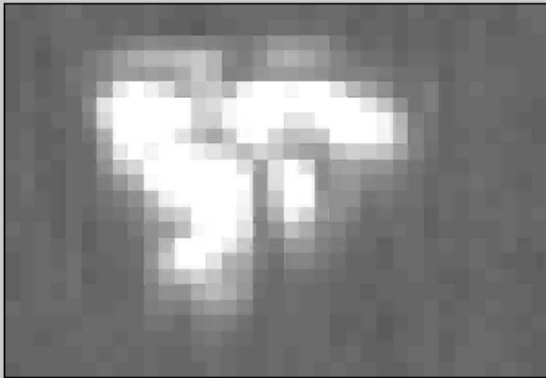
- Image acquired in 20 s, limited by mechanical stage
- Goal : qualify system (target reflectance, spatial resolution, sensitivity, etc.), examine phenomenology

Gun Images (rev. 2 optics)



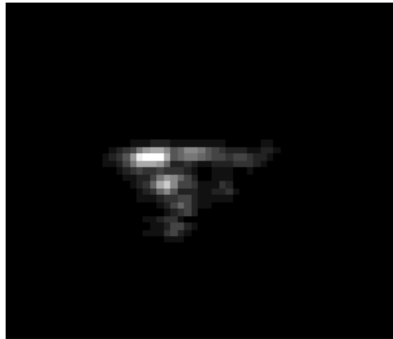
Conclusion #1 : Unpredictable hotspots

Gun Rotation Movie



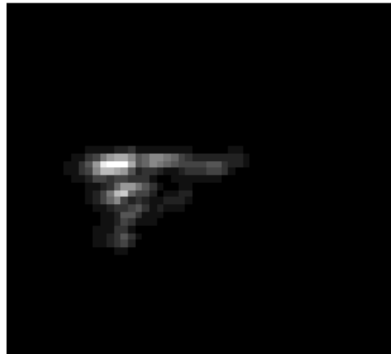
Compare Illumination Modes

CW Illumination



370

FMCW Illumination



400

Pulsed Illumination



54

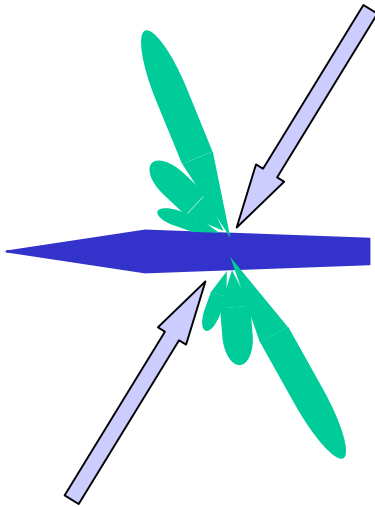
Dynamic Range
(Peak/noise)

Conclusion #3 : Illumination mode (temporal) has little influence on qualitative image quality.

Video imagery: observations

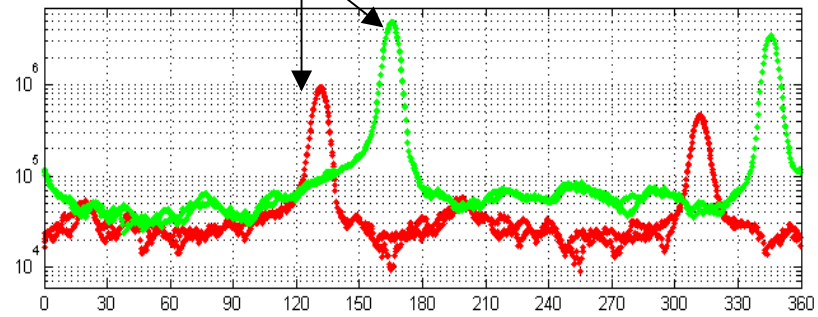
- Some objects show surprising features:

Top View

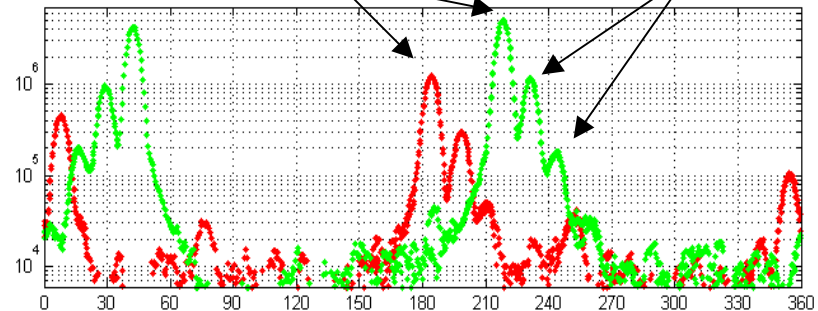


Non-specular peaks are not rotationally symmetric, but have k displaced toward edge

Specular peaks **Metallic Knife**



Specular peaks ??

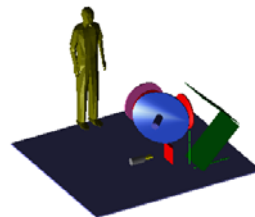
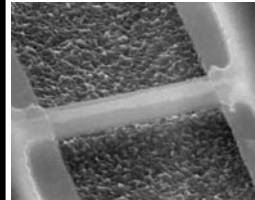
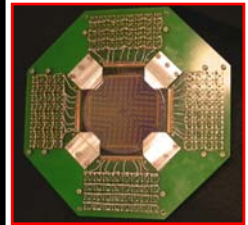


Ceramic Knife

Active THz Imaging Arrays

program directions, milestones

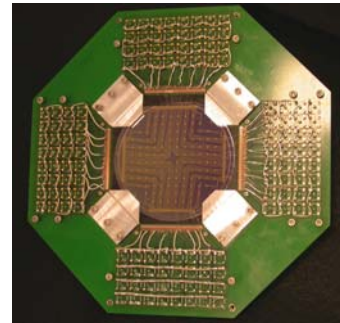
	Format	NEP	Speed	Status
95 GHz, staring FPA (Luukanen 5410-29)	120-element (12x12 less corners)	80 pW/Hz ^{1/2} (elec.) 6-30 % effic.	400 kHz	In use (phenomenology)
95 GHz, Airbridge (Miller 5411-04)	Single-pixel	20 pW/Hz ^{1/2}	30 kHz	Testing prior to insertion in scanned arrays
scanning FPA 95 GHz (Grossman 5411-09)	128 detector X 300 scanpositions	20 pW/Hz ^{1/2} (elec.)		Under construction
650 GHz				proposed



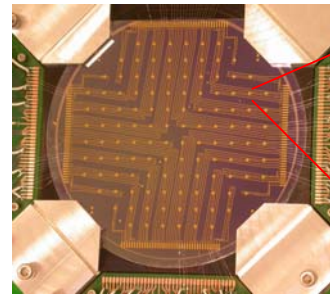
Antenna-coupled Microbolometer Arrays

- ACMB arrays are simple and cheap
 - 4 mask layers + 1 backside etch
 - no semiconductors
 - Si substrates (large diam. possible)
- ACMB arrays are frequency extensible
 - microantenna alone to $> 30\text{THz}$
 - substrate thickness dominates design
- ACMB performance is adequate for active systems
 - NEP $\sim 50\text{-}100\text{ pW/Hz}^{1/2}$
 - Speed $\sim 400\text{ kHz}$
 - pixel count limited by real estate, now ~ 100

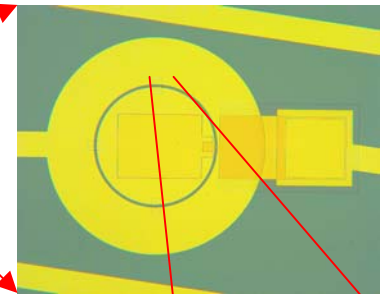
This speed can be traded for pixel count via scanning



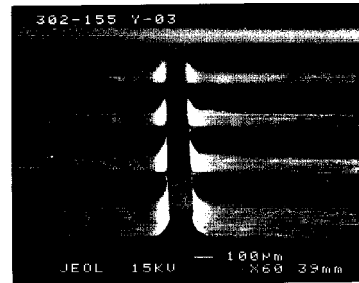
- Prior mmw ACMB arrays
 - Tong (1983)
 - Rebeiz (1990)
 - Hu (1996)
 - and many others



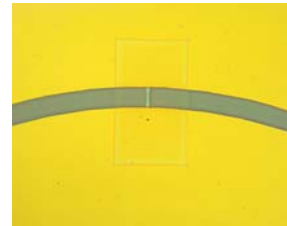
4.75 mm array pitch



1.6 x 10 x .02 μm bolometer

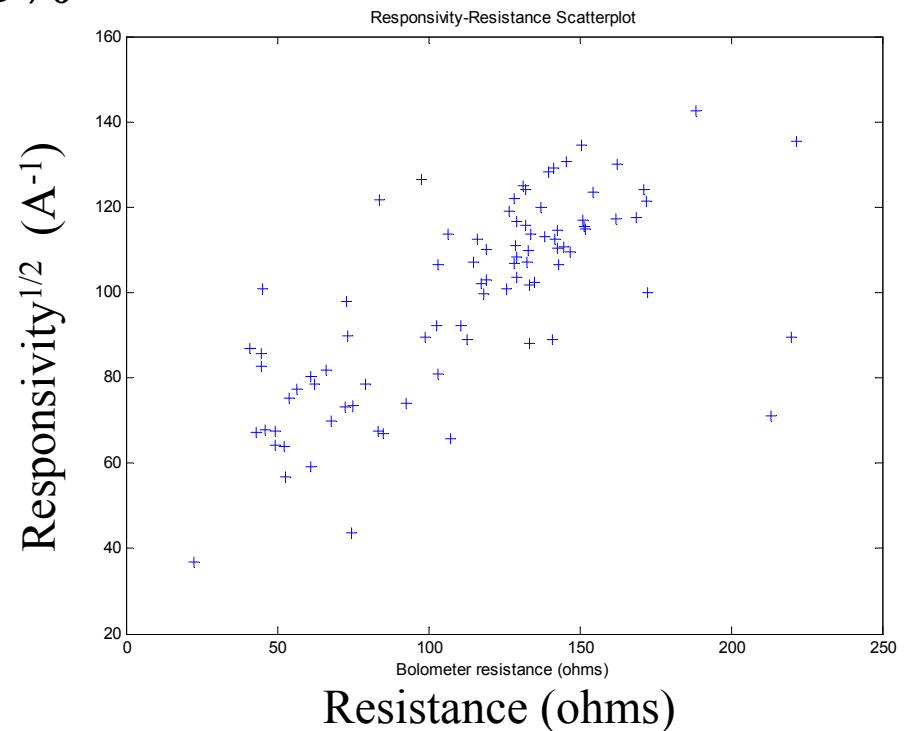
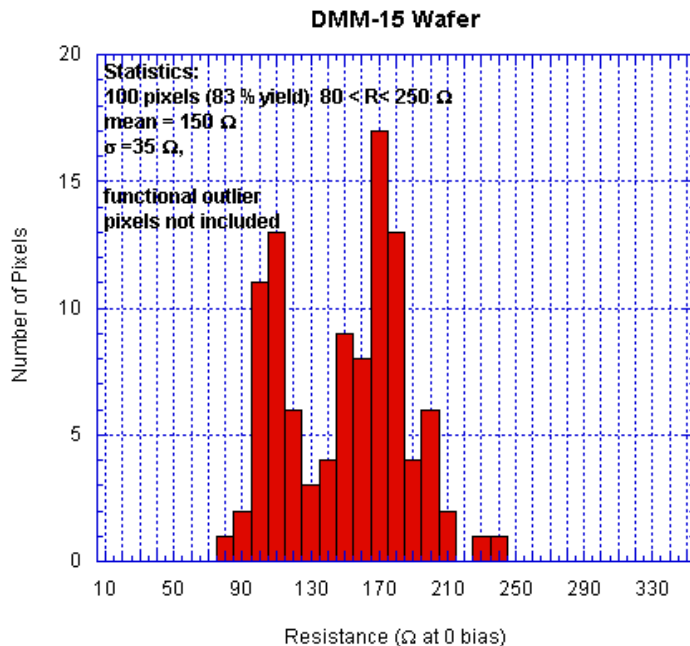


160 μm
55 μm



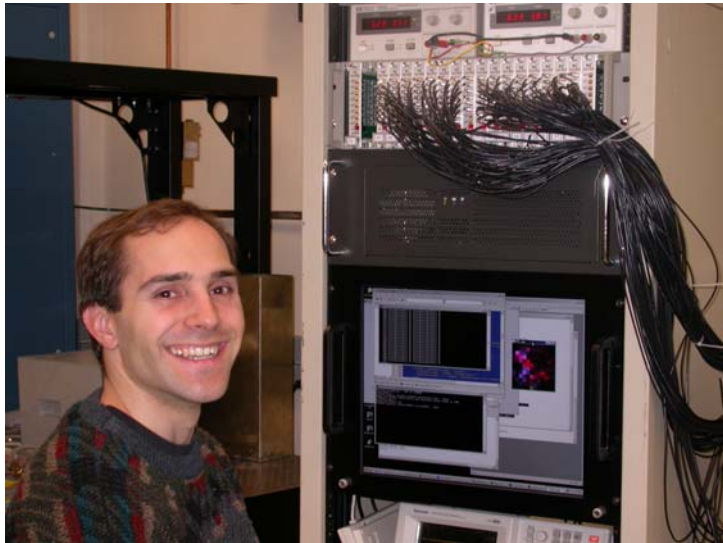
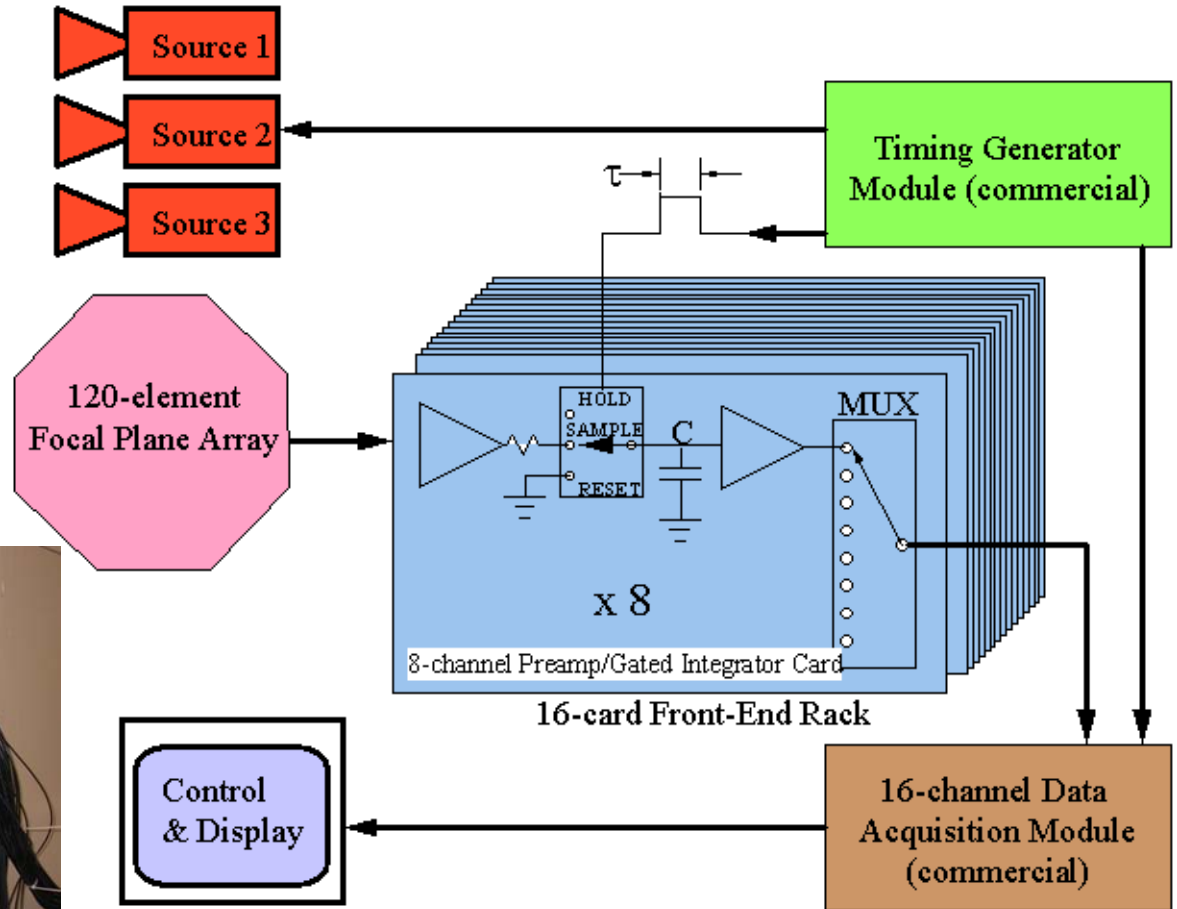
Array Uniformity

- Current FPA's show +/- 39 % (1 σ) uniformity in R
- Correlation between R and Responsivity indicates nonuniformity is limited by linewidth variation
- Optical “flat-fielding” indicated
- Conversion to projection lithography has improved the R- nonuniformity to $\sim 5\%$



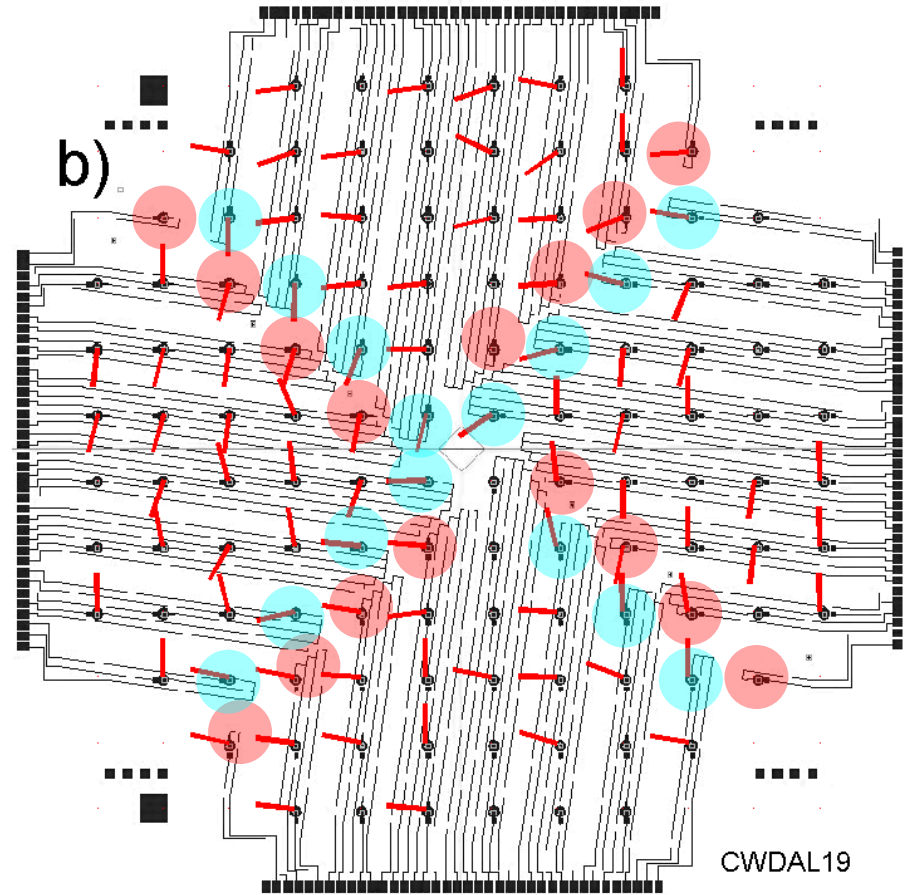
Active Imaging System Block Diagram

- “Brute-force” repetition of 120 channels amplification and gated integration (8 chan. per card)
- Real-time readout
- ASIC-able



FPA Optical characterization

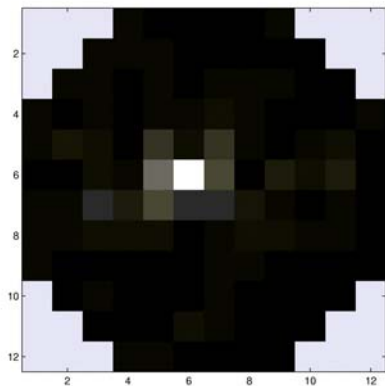
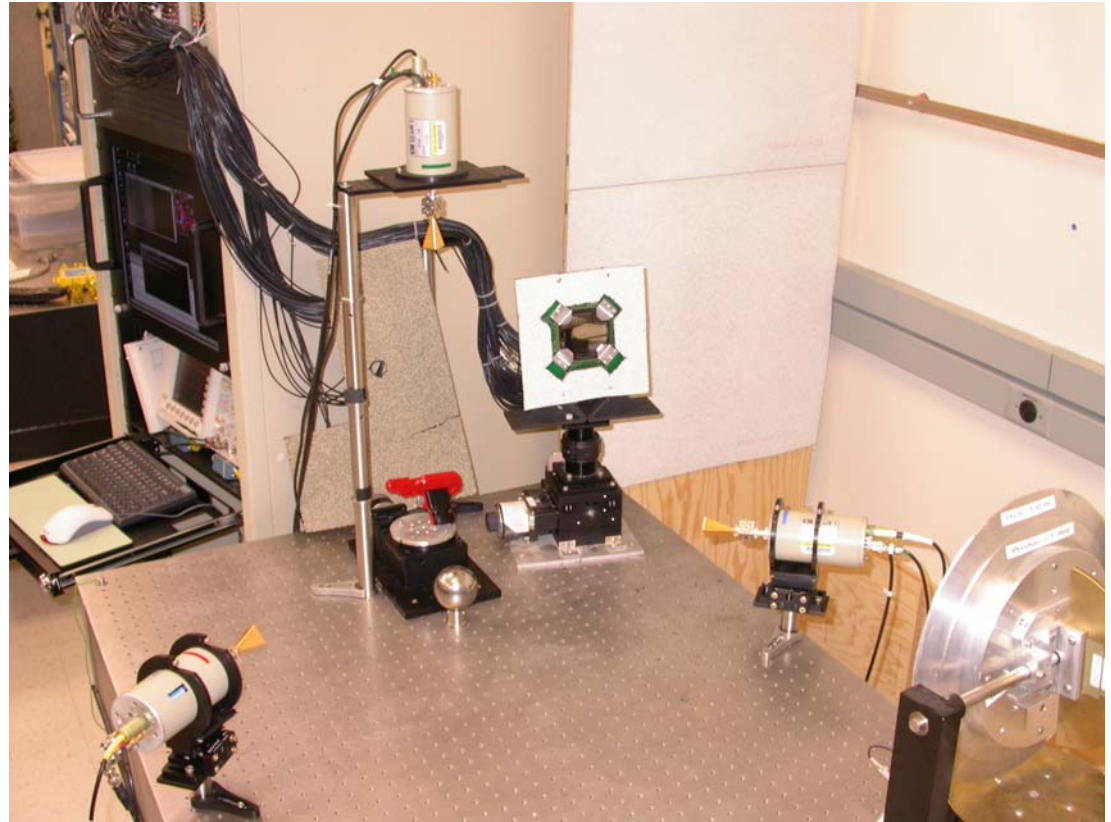
- Polarization measurement carried out by rotating a source 180° , while acquiring a 'movie' with the FPA
- Pixels at the CCW edge show anomalous polarization response
- May be due to coupling to the straight section at the end of these bias circuits
- However, unless this effects the pixel to pixel cross-talk, effect can be corrected using flat field measurements for both polarizations
- These pixels are not the same as the ones showing high coupling efficiency



- =Anomalous polarization response
- =High coupling efficiency

3-D Illumination System

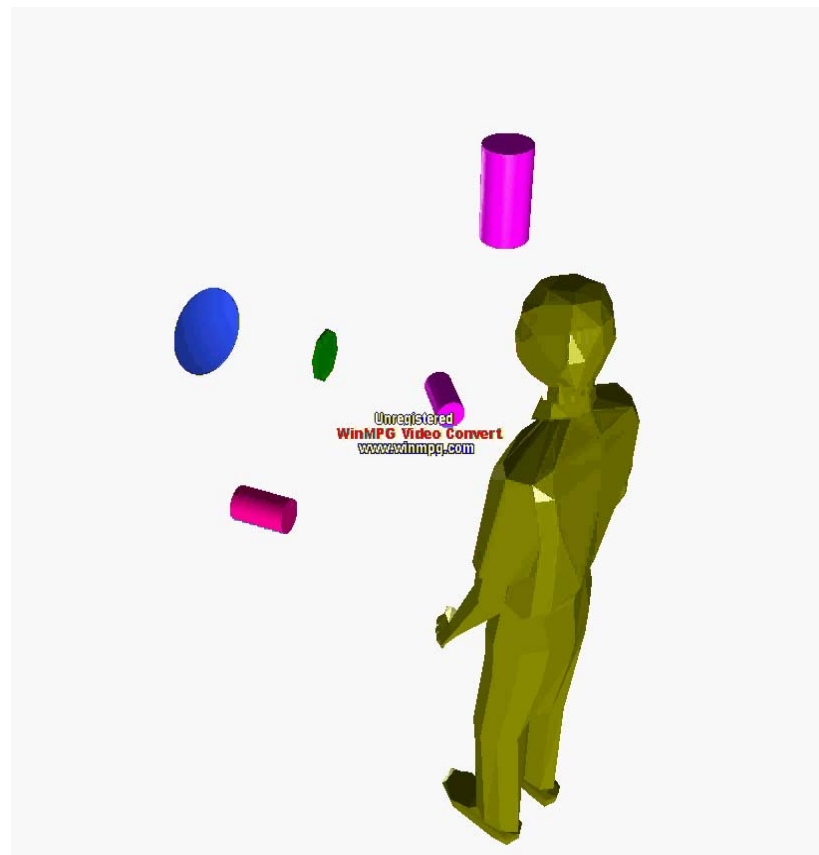
- Illuminate from X, Y, and Z directions
- Detect from (1,1,1) Direction
- 1 m radius spherical collecting mirror, at unity magnification
- Source pulse trains are interlaced in time



Map of point source (open ended WR-10)

Video imagery

- Video imagery acquired for various objects
- A stream file allows for post processing of the videos
- Color coding of the three sources facilitates image interpretation
- Polarization of sources set to 45° in order to obtain signal from all FPA quadrants



Video imagery: point source movie

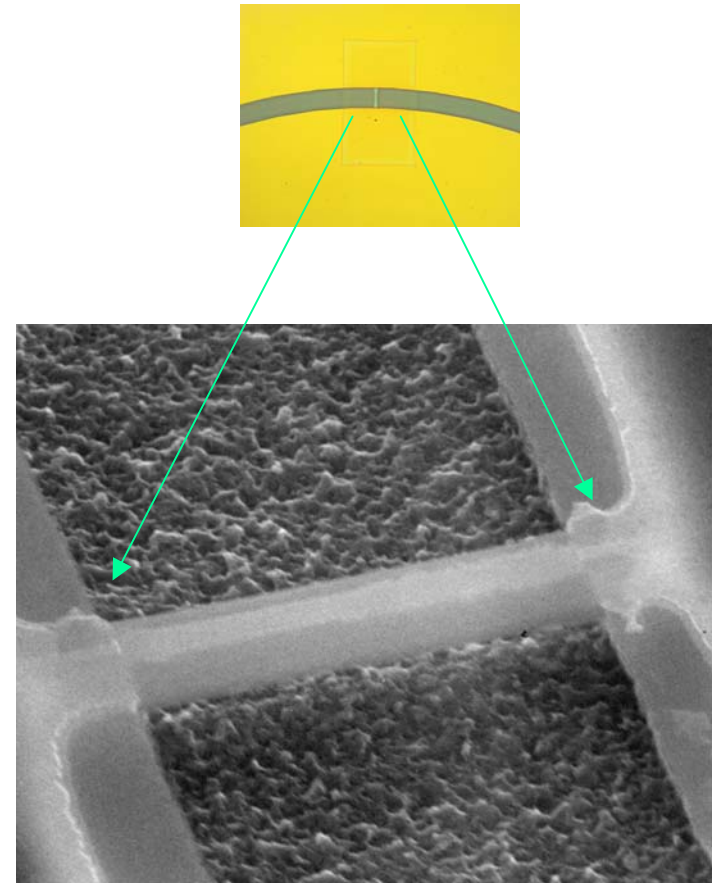
Video deleted for size

Video imagery: Suicide bomber

Video deleted for size

Airbridge Microbolometers

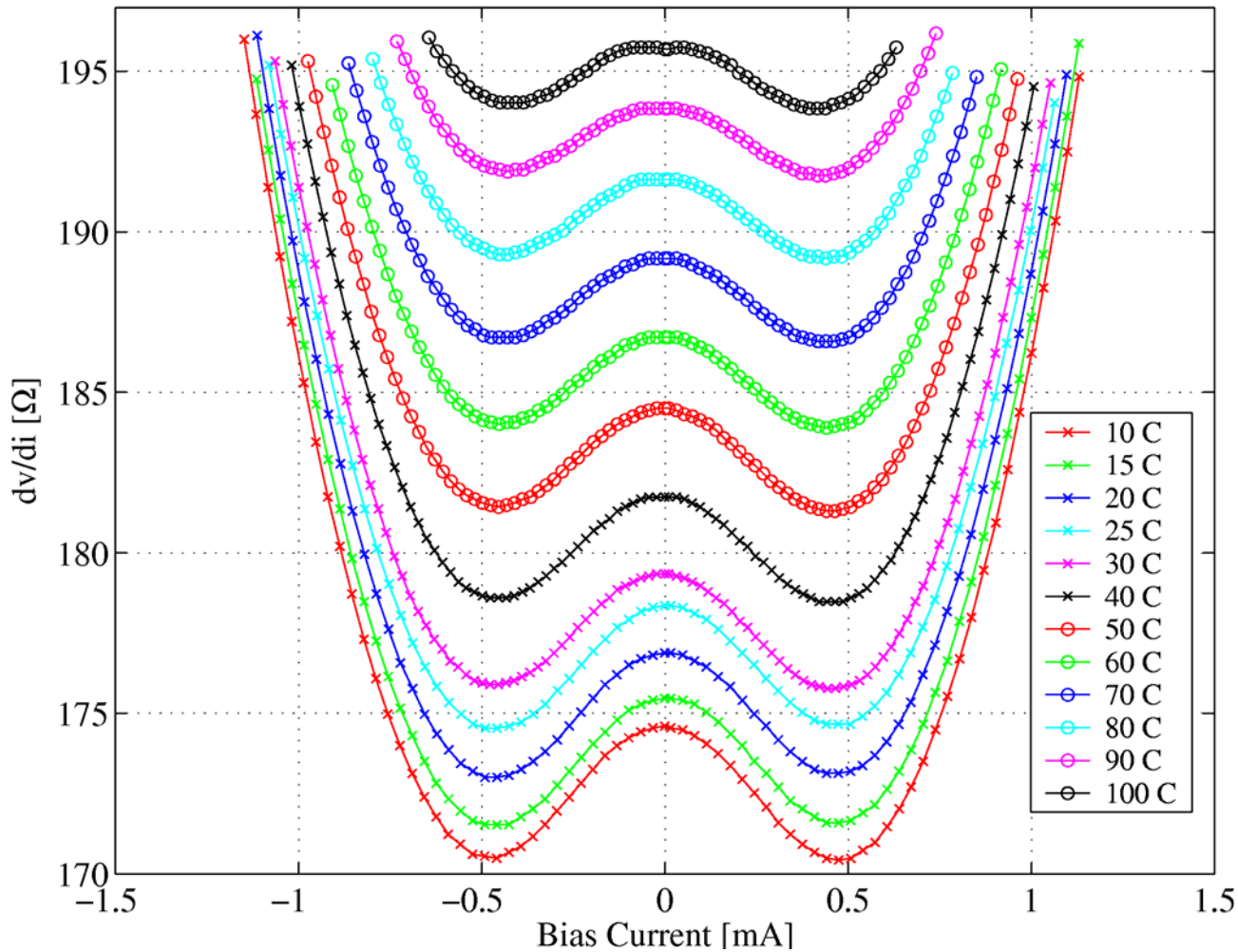
- Current FPA microbolometers
 - 5-10 V/W-mA
 - 25-50 V/W
 - 400 kHz
- Airbridge
 - 40 – 80 V/W-mA
 - 100 V/W
 - 50 kHz (est.)
- Optimum (for 1D scanned system)
 - maximize V/W consistent with
 - ~ 20-40 kHz bandwidth



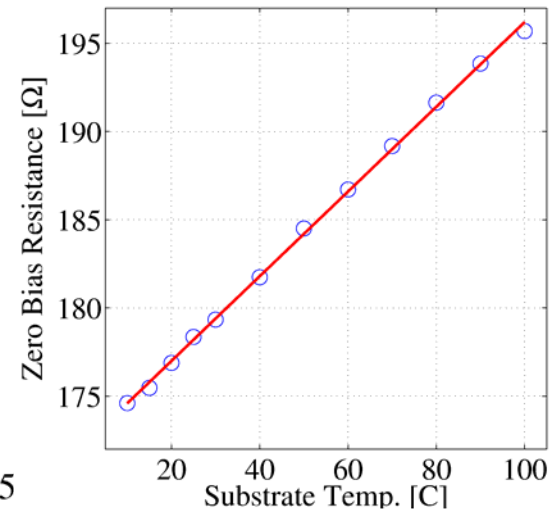
10 micron airbridge,
Nb strip passivated in SiO₂,
Released with XeF₂ etch
Of underlying Si

Air-Bridge dv/di vs. T

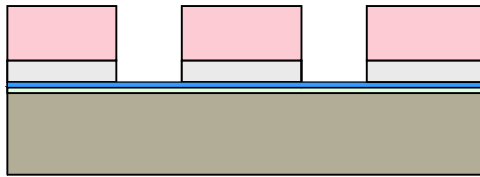
Differential Resistance vs. Substrate Temperature



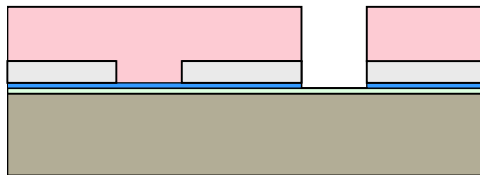
- **Al antenna metal**
- Maximum $I_{\text{bias}} \approx 1.7$ mA
- $G = 4.5 \mu\text{W/K}$
- Johnson-noise limited
- $\tau \approx 4 \mu\text{s}$
- $TCR = 0.13$ % per degree K
- $\beta = 54$ V/(W·mA)
- Responsivity = 86 V/W



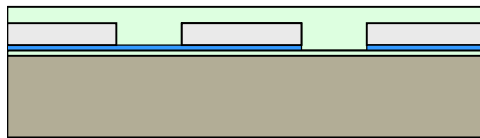
Air-Bridge Bolometers



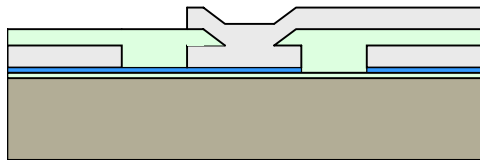
Pattern Antenna



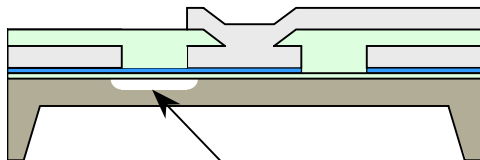
Pattern Bolometer



Deposit Insulator







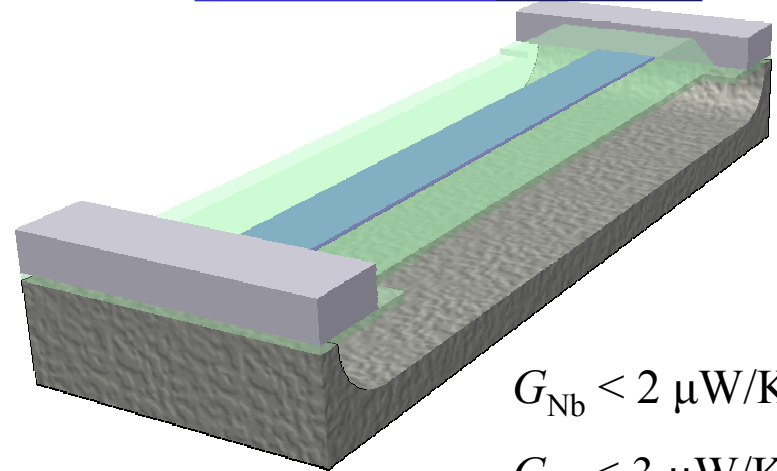
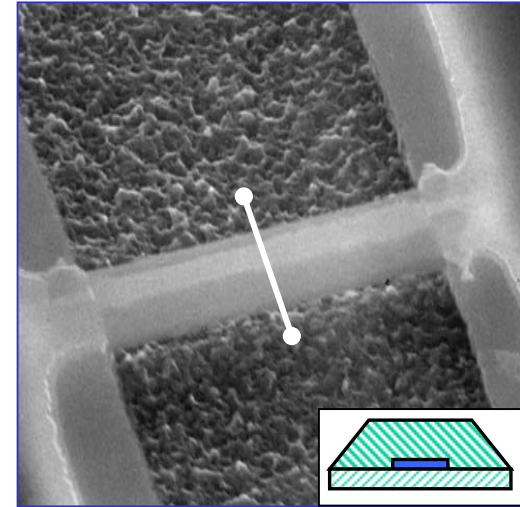
Pattern Wiring



Substrate Etch

Air Gap

 Photoresist	 Bolometer Metal
 Aluminum	 SiO ₂ Insulator



$$G_{Nb} < 2 \mu\text{W/K}$$

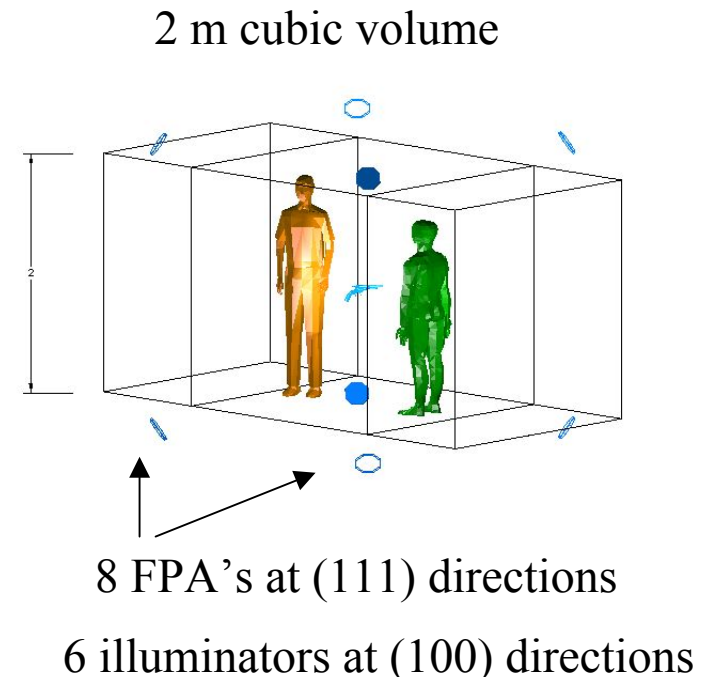
$$G_{air} < 3 \mu\text{W/K}$$

$$G_{ox} < 2 \mu\text{W/K}$$

Can the 2D Staring Array Approach be Scaled Up ?

- Present antenna-coupled bolometer arrays lack either pixel count, sensitivity, or speed
- Surface of the human body is $\sim 3 \text{ m}^2$.
- At 1 cm resolution, $\sim 30 \text{ kpixels}$ needed : FPA real estate is a serious problem for scale up of staring arrays
- Scanning requires fewer pixels, but higher speed
- Higher frequency provides more pixels, but requires more sensitivity (to compensate for clothing penetration)

8 x (60 x 60) FPA's,
35-54 degree antenna halfwidth
(7 – 11 dB directivity)



Real Estate for Staring Arrays

- Mindless scale-up of an uncooled IR FPA doesn't work:
 - 25 μm pixels become 8 mm pixels (95 GHz)
1.15 mm pixels (650 GHz)
 - So 20 kpixel (120 x 160) array is 1.2 m at 95 GHz, 18 cm
 - Poorly matched to density of CMOS readout circuits
- Consider compressing array:
Must match antenna beamwidth and optics speed
(smaller antennas have broader beams)

Optics requirements become very severe (\$\$) for large field-of-view

Video imagery: observations

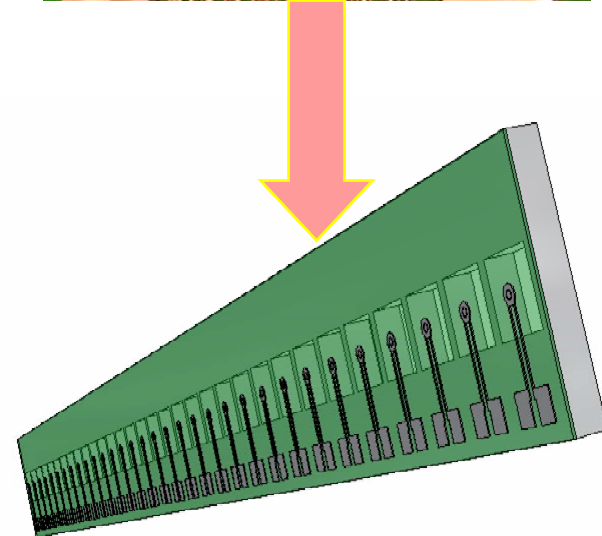
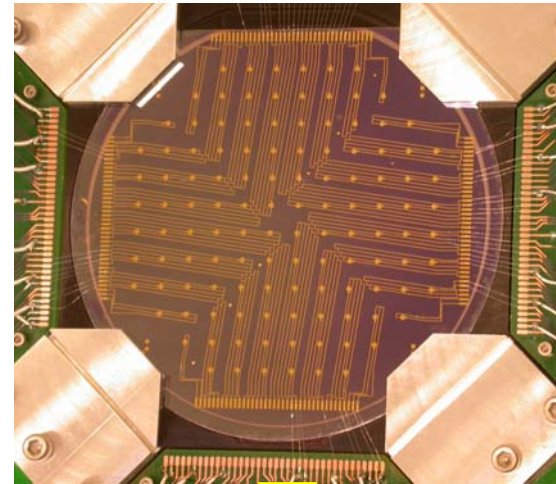
- Signal to noise ratio is clearly sufficient for detection
- Object recognition is challenging due to the small number of pixels & poor spatial resolution
- Strong specular reflections from objects at certain orientations
- Strong returns also from the skin
- *However, with larger pixel count & improved spatial resolution these issues can be tackled*

*Imagery is clutter,
not detector noise
limited*

1D Scanned System

The Quest for more pixels

- Instead of 2D array (12x12 pixels) use a linear array (1x128 pixels)
- Conical scanning optics, combined with a *linear* 128 pixel array (using the same readout)
- Yields 128x300 image pixels without sacrificing SNR
- Linear array pixels – greatly relaxed wiring requirements → improved coupling efficiency (~30 %)
- New IMPATT source, $P_{\text{peak}}=10 \text{ W}$, $P_{\text{ave}}=50 \text{ mW}$
- Overall, SNR improvement by a factor of ~600 expected!
- The sensitivity improvement helps especially in longer range applications

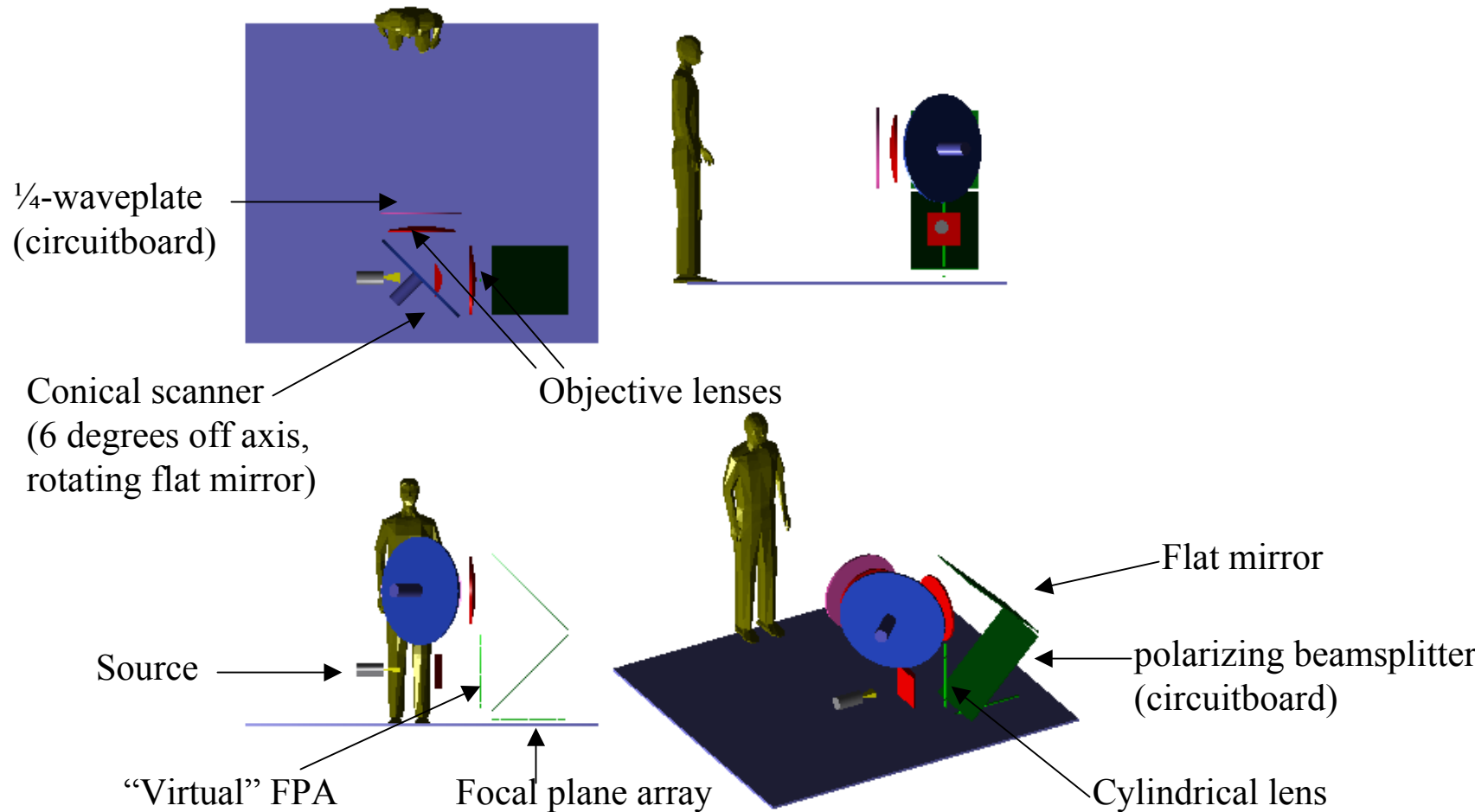


Active Systems favor Scanning Architectures

- If performance is sensitivity-limited, and
 - total illumination power
 - frame time
 - number of image pixels } fixed $N_{pix} = N_d \times N_{scan}$
- duty cycle = pixel time/frame time = $1/N_{scan}$
- Divide power among N_d detectors (illuminate only where scanning)
 - Power per pixel $\propto N_d^{-1}$
 - Pixel time $\propto N_d$
 - $SNR \propto (\text{power per pixel}) \times (\text{pixel time})^{1/2} \propto N_d^{-1/2}$
- Optimum is fewer detectors, scanned faster, up to limits of scanner and detector speeds

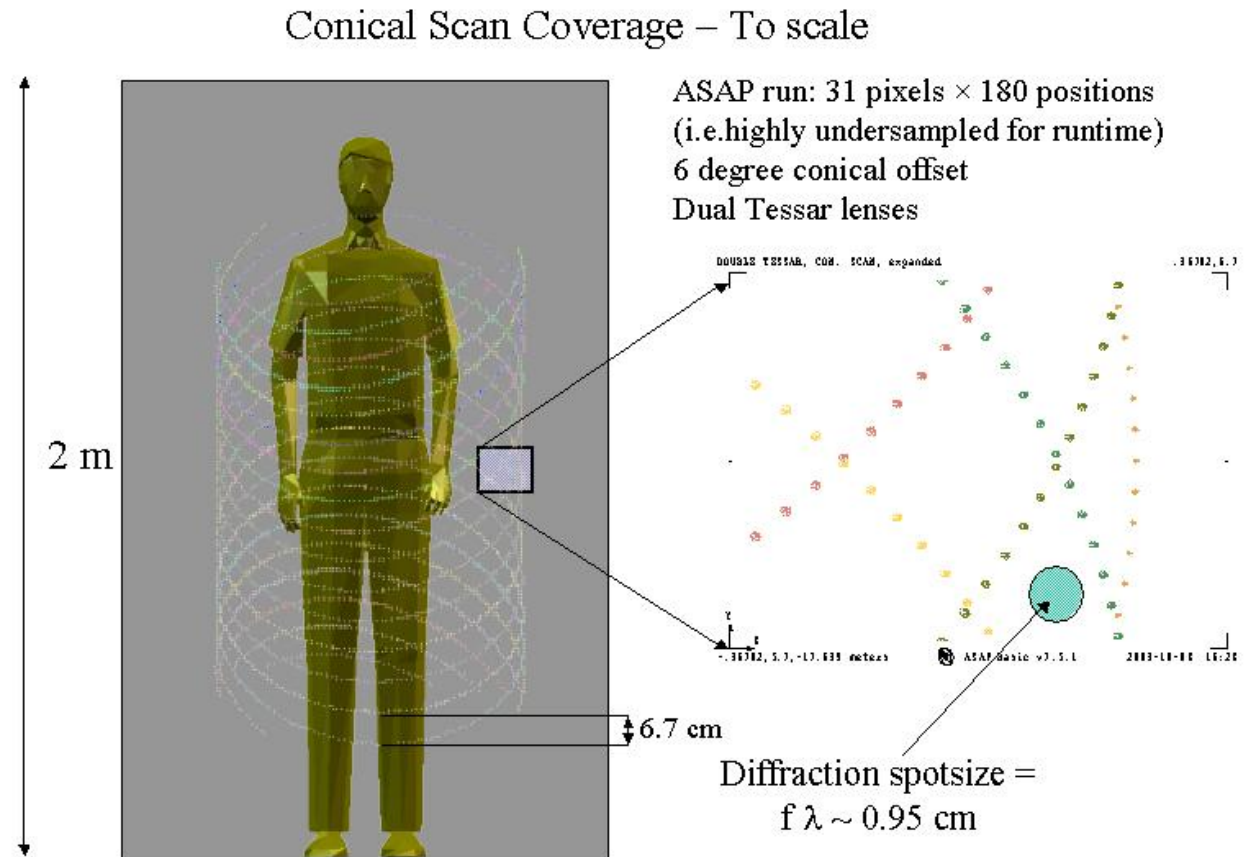
If noise is not white,
scanning is even more favored

High Pixel-count, MM-wave Scanning System

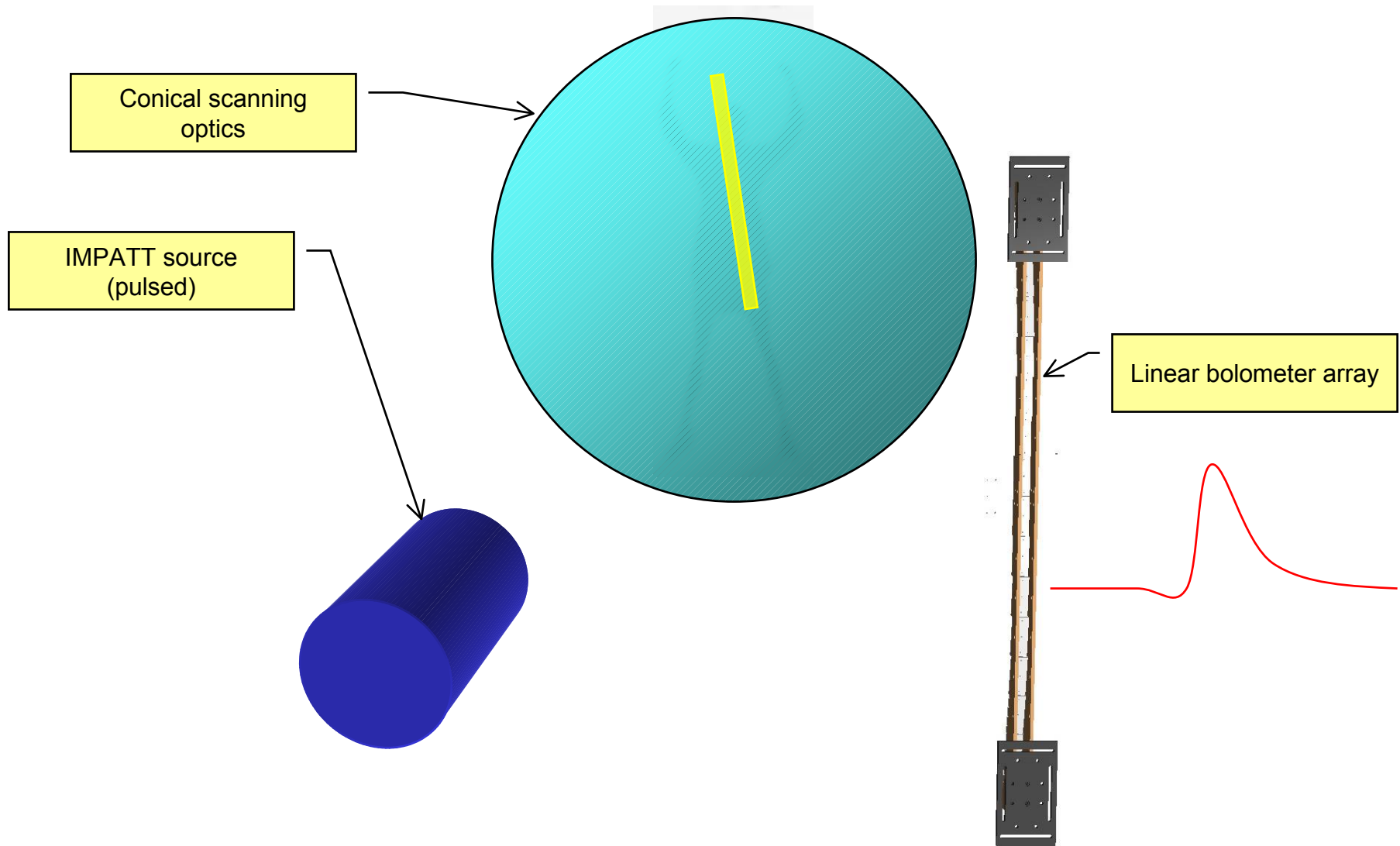


Conical Scan Sampling

- Pixel count
128 detectors x
300 scan angles
= 38.4 kpix
- redundancy

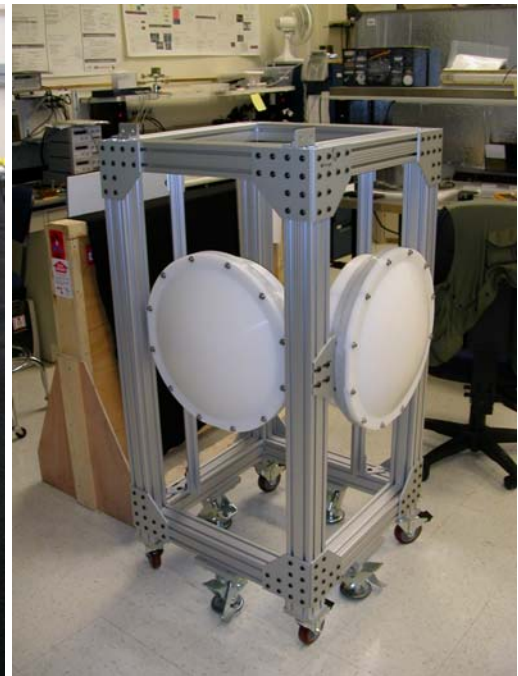
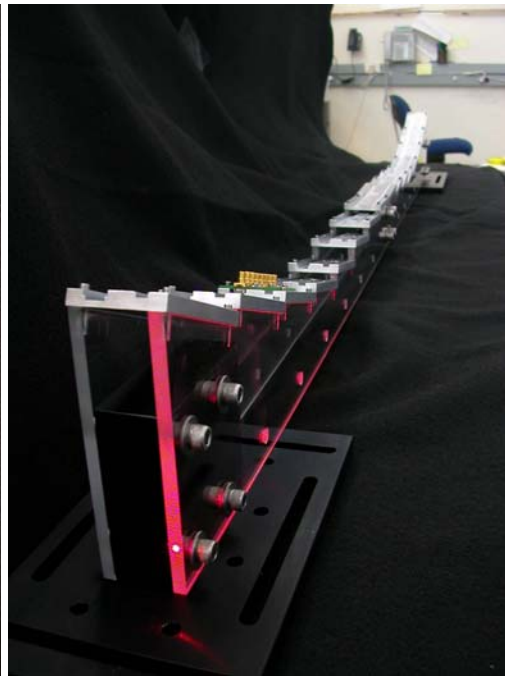
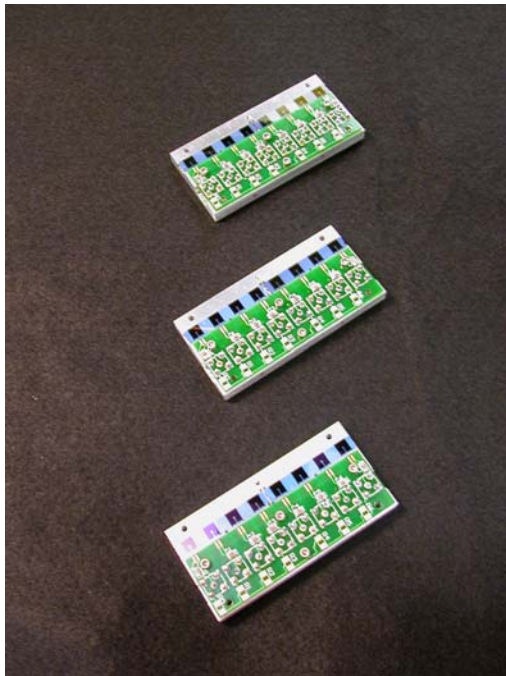


Linear array & Conical scanning



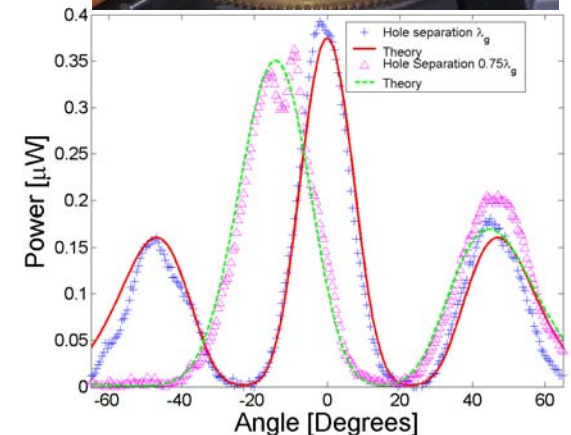
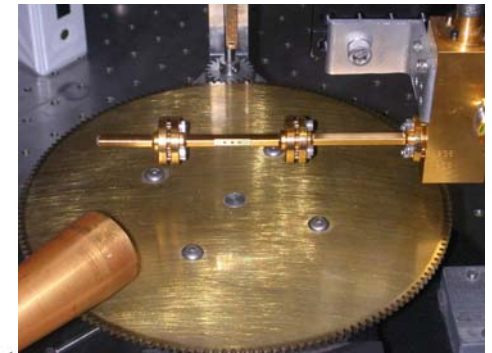
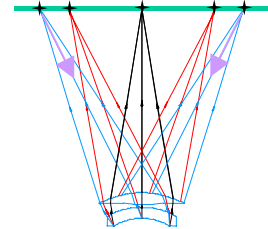
Linear array & Conical scanning

- The linear array consists of 16 modules with 8 pixels each
- Modules mount onto a “spine”
- Optics: aspheric doublet lenses (Polyethylene), $D=48$ cm, total loss = 1.3 dB at 95 GHz, diffraction-limited over ± 35 degree FOV at $f/3.1$



Line Source

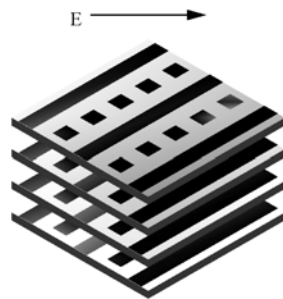
- Desired source is an image of FPA
 - linear array of point sources, emitting into $f/2.5$ cones pointed toward exit aperture
- At 95 GHz, implemented in waveguide
 - narrow wall holes emit as magnetic dipoles
- At 650 GHz, implement quasioptically with crossed cylindrical lenslet array



$\lambda / 4$ plate and polarizer

- Fabrication by laser printer, then metallic lamination

- see Kondo, T. Nagashima, T. Hangyo, A. (2002), Conf. Digest for 27th Intl. Symp. IR and Mm Waves
- large area (8 1/2 x 11)
- low cost
- 100 μm linewidth well defined
- high resistivity circumvented with electroplating

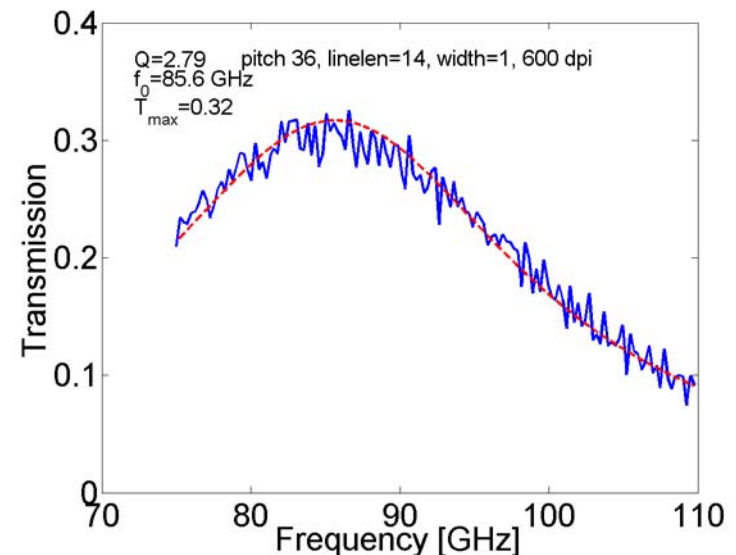
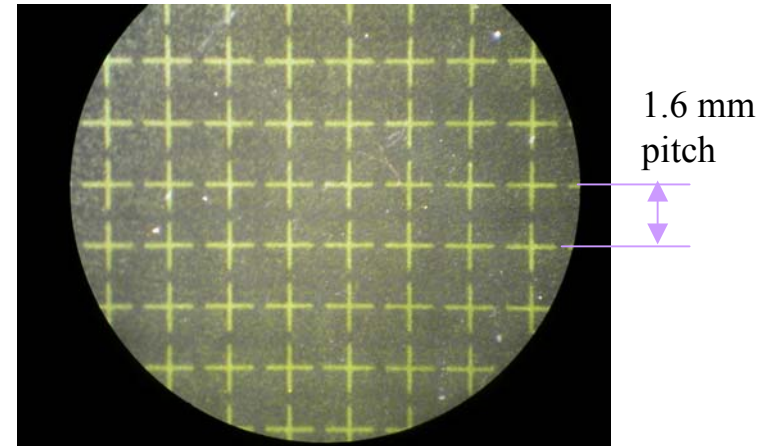


- “Waffle-grid” $\lambda / 4$ plate design

- CU Boulder development

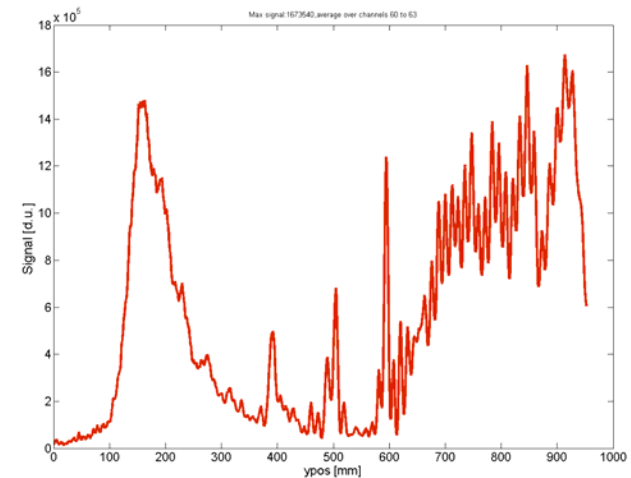
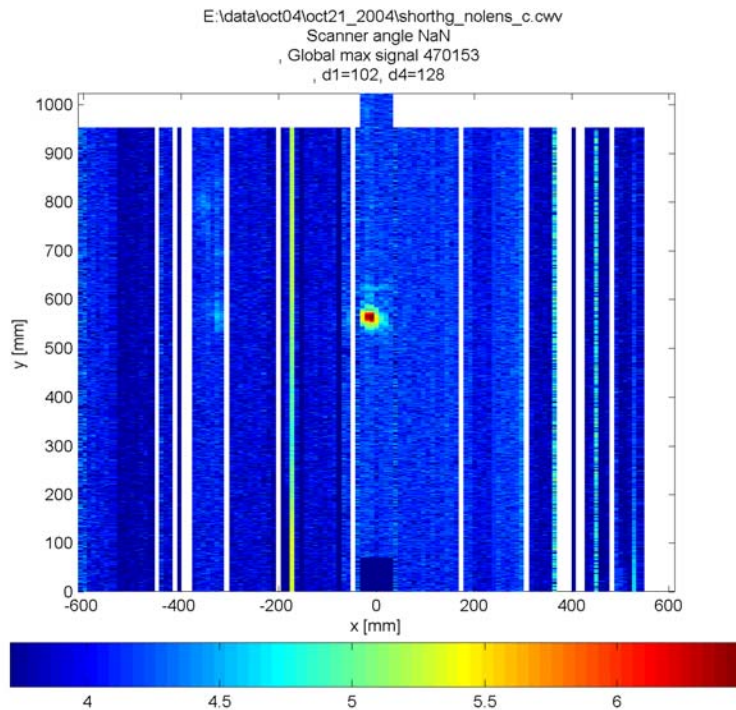
- Leong and Shiroma, Elec. Lett. 38(22) (2002)
- Shiroma and Popovic (Microwave and Guided Wave Lett. 6(5) (1996)

Laserprinted crossed-slot bandpass filter



Linear array & Conical scanning

- System verification under way
 - Imaging of the source on the detector array to verify the illumination conditions & coupled power
- Issues found: interference of triplets



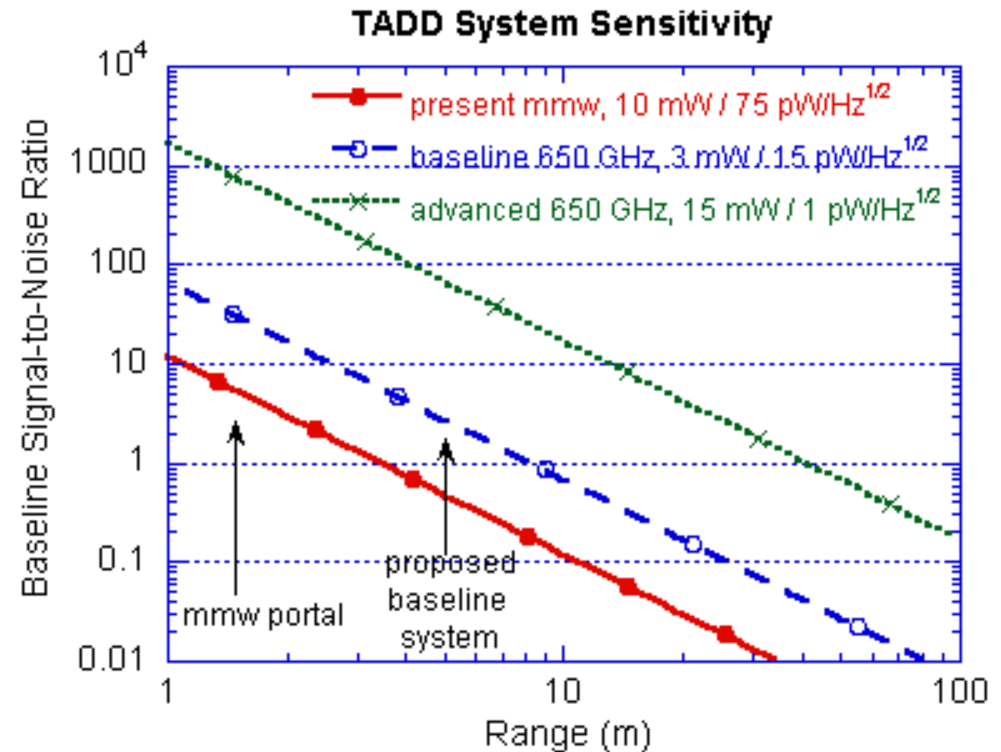
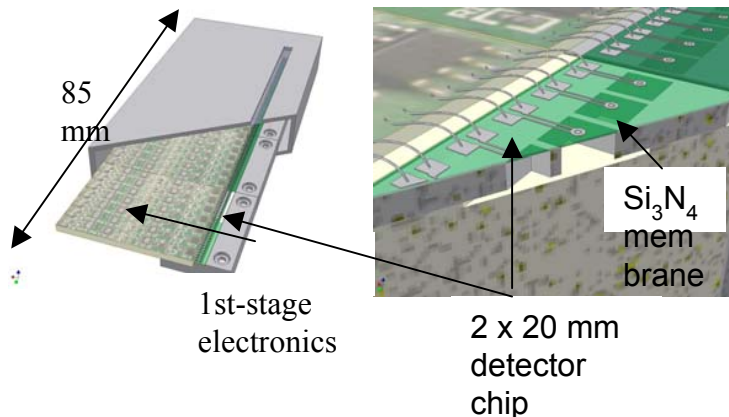
Migration to 650 GHz TADD System Specifications

Specification	Value	Specification	Value
Frequency	655 GHz	Pixel count	128 \times 300
Range	5 m	Illumination power	3 mW
Aperture Size	25 cm	Illumination efficiency	25 %
Field-of-view	2 \times 4 m (h \times w)	Detection efficiency	50%
Frame Rate	30 Hz	NEP	5 pW/Hz ^{1/2}
Spatial resolution	1 cm	S/N ratio (one 30 Hz frame)	3

Table 1. Baseline TADD system specification and performance

THz Active Direct Detection Sensitivity

- Source power and detector NEP control range
- R^{-2} dependence
not R^{-4} (conventional radar)
target in near field of aperture



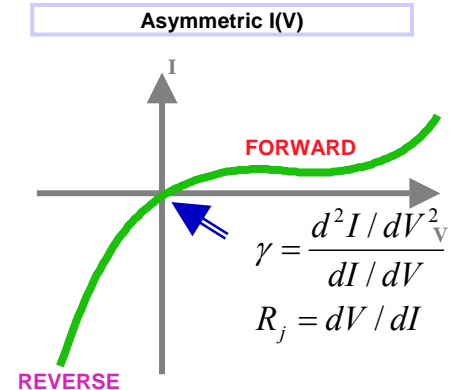
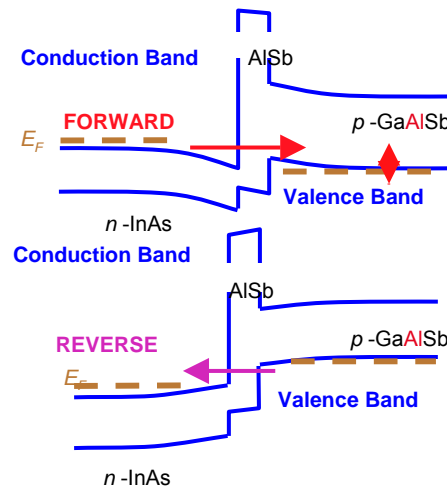
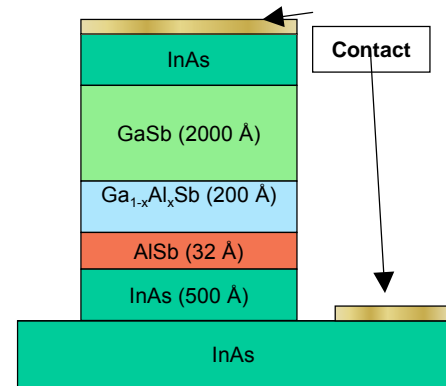
Sb-heterostructure quantum tunneling diodes

in collaboration with HRL Laboratories, Malibu, CA

Joel N. Schulman

Harris P. Moyer

- Diodes, unlike bolometers, do not suffer from phonon noise, but:
 - Schottky diodes (the most common diode detector) require a dc bias for sensitivity & impedance matching and suffer from huge $1/f$ noise
 - Detection is typically done *after* a RF amplifier
 - Their RF bandwidth is limited by the RC of the junction resistance & capacitance \rightarrow small area required for high frequency operation
- **HRL Sb-heterostructure zero-bias diodes**
 - basic operation similar to the Esaki diode
 - Type II band gap alignment: n-InAs Conduction band minimum lies energetically below the valence band maximum in p-GaAlSb \rightarrow asymmetry in $I(V)$ characteristics.
 - Large nonlinearity at zero bias \rightarrow *no* $1/f$ noise
 - $(2 \mu\text{m})^2$ diodes fabricated from epitaxial layers of InAs & GaAlSb using MBE



Sb-heterostructure quantum tunneling diodes: noise characterization

- Matched source, infinite load

Responsivity:

$$\mathfrak{R}_{v0} = \frac{R_j \gamma}{2} \frac{1}{\left\{ \left(1 + R_s / R_j\right) \left[1 + R_s / R_j + R_s R_j C_j^2 \left(\Lambda \omega^2 / 4 + 3 \omega_c^2 \right) / 3 \right] \right\}}$$

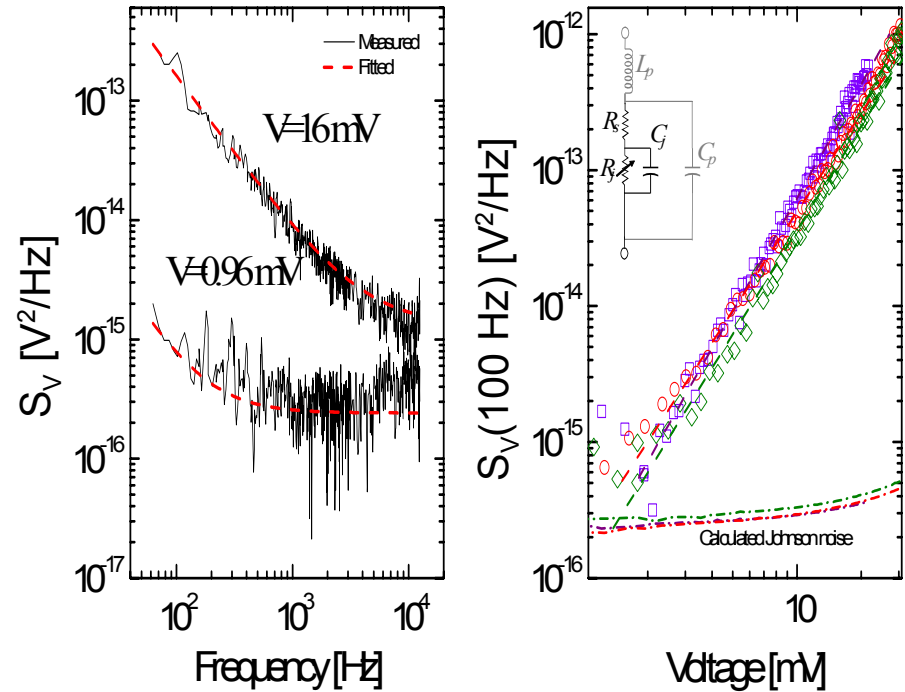
- NEP = noise/responsivity

- At $V=0$, $\omega_c / 2\pi = 95$ GHz

- Best matched NEP ~ 1 pW/Hz^{1/2}

- Best unmatched NEP ~ 4 pW/Hz^{1/2} ($Z_s = 100\Omega$)

- Significant improvement over antenna-coupled microbolometers (10-25 pW/Hz^{1/2})



$$S_V(f) = V_j^2 + V_{1/f}^2 + V_s^2,$$

$$V_j^2 = 4k_B T R_j(V)$$

$$V_{1/f}^2 = \alpha V^m f^{-r}$$

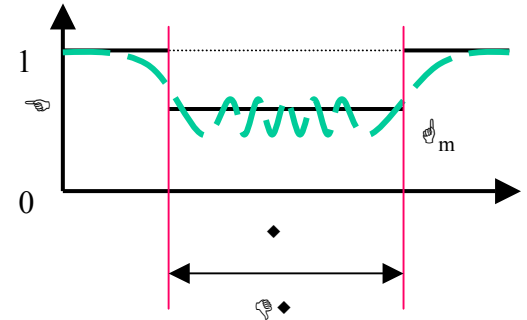
$$V_s^2 = 2eI \left(\frac{dV}{dI} \right)^2$$

Matching considerations for passive direct detection

- Broader detector bandwidth – more signal power – more difficult impedance matching
- The Bode-Fano criterion gives the minimum average reflection coefficient Γ_m for an arbitrary impedance matching network:

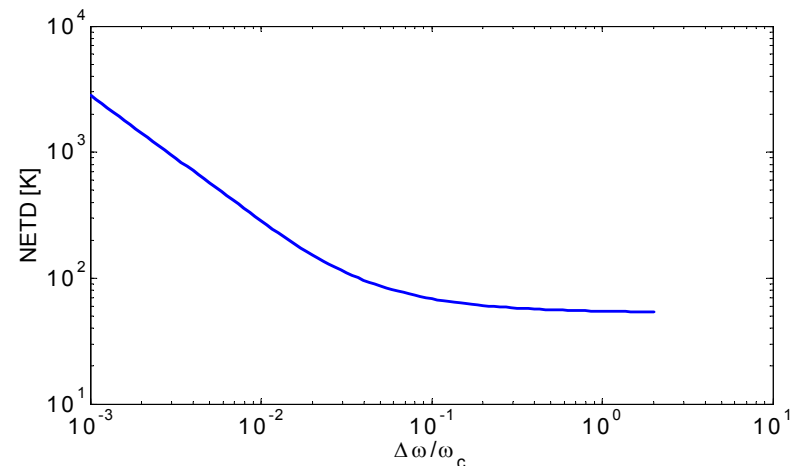
$$\Gamma_m \geq e^{-\pi / \Delta\omega RC}$$

- Fraction of delivered power $\approx 1 - |\Gamma_m|^2$
- NETD is the true figure of merit for passive imaging of broadband (thermal) sources
- Enforcing the B-F criterion yields a best NETD ~ 53 K for these non-optimized devices
- With further reduction in R_j , C_j , NETD ~ 6 K is possible! □ sufficient for many imaging applications



$$NETD = \frac{NEP_m}{\eta \Delta f k_B \sqrt{2\tau_{int}}}$$

$$NETD = \frac{NEP_m(\Delta\omega)}{(1 - e^{-1/\Delta f R_j C_j}) \Delta f k_B \sqrt{2\tau_{int}}} \approx \frac{NEP_m R_j C_j}{k_B \sqrt{2\tau_{int}}}, \Delta f \rightarrow \infty$$



Active Imaging with ACMBs

- Fundamental trade-off: Cost & Complexity vs. sensitivity
- Antenna-coupled microbolometers are by far the simplest of the detector candidates
- What room temperature bolometers lack in sensitivity can be compensated with *the use of illumination: 5000 \$ source → 5 mW average power (increase by 8 orders of magnitude!)*
- Program started in 2001 to develop a system demonstrator with pulsed noise sources & antenna-coupled microbolometers
- Moderate (120) pixel count to provide a system to study the phenomenology of active video rate mmw imaging

Conclusions

- For advanced checkpoint CWD, both mmw/THz and x-ray backscatter imaging offer penetration and resolution
- The relative advantages of mmw/THz and XRB depend on application details. Mmw/THz has advantages in
 - safety/privacy
 - throughput
 - cost
- An active mmw/THz imager based on bolometers
 - is simple and cheap
 - scales easily to THz frequencies
 - has enough sensitivity for CWD at ranges up to 5 m without any breakthroughs in component performance